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COLOR MONITOR **SERVICE MANUAL**

CHASSIS NO. : CA-136

MODEL: StudioWorks 710B (**710BL-AL**E**)

StudioWorks 710S (**710BL-AL**M, AL**B**)

StudioWorks 710E (**710BL-AL**A**)

StudioWorks 773N (**773NL-AL**M**)

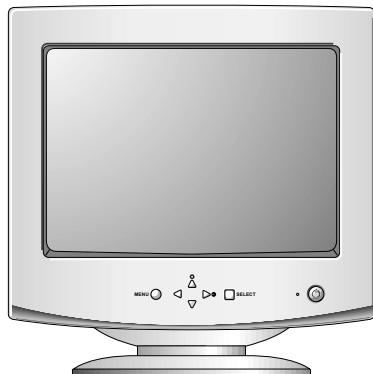
StudioWorks 773E (**773NL-AL**E**)

() **Same model for Service

CAUTION

BEFORE SERVICING THE UNIT,

READ THE **SAFETY PRECAUTIONS** IN THIS MANUAL.



*Same looking with new chassis.

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SPECIFICATIONS

1. PICTURE TUBE

Size	: 17 inch
Deflection Angle	: 90°
Neck Diameter	: 29.1 mm
Dot Pitch	: 0.27 mm
Face Treatment	: W-ARASC (Anti-Reflection and Anti-Static Coating)
Low Radiation	: MPR II, TCO 99

2. SIGNAL

2-1. Horizontal & Vertical Sync

- 1) Input Voltage Level : Low=0~1.2V, High=2.5~5.5V
- 2) Sync Polarity : Positive or Negative

2-2. Video Input Signal

- 1) Voltage Level : 0 ~ 0.7 Vp-p
- a) Color 0, 0 : 0 Vp-p
- b) Color 7, 0 : 0.467 Vp-p
- c) Color 15, 0 : 0.7 Vp-p
- 2) Input Impedance : 75 Ω
- 3) Video Color : R, G, B Analog
- 4) Signal Format : Refer to the Timing Chart

2-3. Signal Connector

3 row 15-pin Connector (Attached)

2-4. Scanning Frequency

- Horizontal : 30 ~ 71 kHz
- Vertical : 50 ~ 160 Hz

3. POWER SUPPLY

3-1. Power Range

AC 100-240V~ 50/60Hz, 1.0A Max.

3-2. Power Consumption

MODE	POWER CONSUMPTION	LED COLOR
MAX	85 W	GREEN
NORMAL (ON)	73 W	GREEN
STAND-BY	less than 15 W	FLASH
SUSPEND	less than 15 W	
OFF	less than 5 W	FLASH

4. DISPLAY AREA

4-1. Active Video Area :

- Max Image Size - 326.7 x 245.5 mm (12.86" x 9.67")
- Preset Image Size - 310 x 230 mm (12.20" x 9.06")

4-2. Display Color : Full Colors

4-3. Display Resolution : 1280 x 1024 / 60Hz(Max) (Non-Interlace)

4-4. Video Bandwidth : 110 MHz

5. ENVIRONMENT

5-1. Operating Temperature: 0°C ~ 40°C (Ambient)

5-2. Relative Humidity : 10%~ 90% (Non-condensing)

5-3. Altitude : 5,000 m

6. DIMENSIONS (with TILT/SWIVEL)

Width	: 400.0 mm (15.74 inch)
Depth	: 411.0 mm (16.17 inch)
Height	: 397.5 mm (15.65 inch)

7. WEIGHT (with TILT/SWIVEL)

Net Weight	: 14.0 kg (30.92 lbs.)
Gross Weight	: 16.6 kg (36.60 lbs.)

SAFETY PRECAUTIONS

SAFETY-RELATED COMPONENT WARNING!

There are special components used in this color monitor which are important for safety. **These parts are marked on the schematic diagram and the replacement parts list.** It is essential that these critical parts should be replaced with the manufacturer's specified parts to prevent X-radiation, shock, fire, or other hazards. Do not modify the original design without obtaining written permission from manufacturer or you will void the original parts and labor guarantee.

CAUTION: No modification of any circuit should be attempted.

Service work should be performed only after you are thoroughly familiar with all of the following safety checks and servicing guidelines.

SAFETY CHECK

Care should be taken while servicing this color monitor because of the high voltage used in the deflection circuits. These voltages are exposed in such areas as the associated flyback and yoke circuits.

FIRE & SHOCK HAZARD

An isolation transformer must be inserted between the color monitor and AC power line before servicing the chassis.

- In servicing, attention must be paid to the original lead dress specially in the high voltage circuit. If a short circuit is found, replace all parts which have been overheated as a result of the short circuit.
- All the protective devices must be reinstalled per the original design.
- Soldering must be inspected for the cold solder joints, frayed leads, damaged insulation, solder splashes, or the sharp points. Be sure to remove all foreign materials.

IMPLOSION PROTECTION

All used display tubes are equipped with an integral implosion protection system, but care should be taken to avoid damage and scratching during installation. Use only same type display tubes.

X-RADIATION

The only potential source of X-radiation is the picture tube. However, when the high voltage circuitry is operating properly there is no possibility of an X-radiation problem. The basic precaution which must be exercised is keep the high voltage at the factory recommended level; the normal high voltage is about 25.8kV. The following steps describe how to measure the high voltage and how to prevent X-radiation.

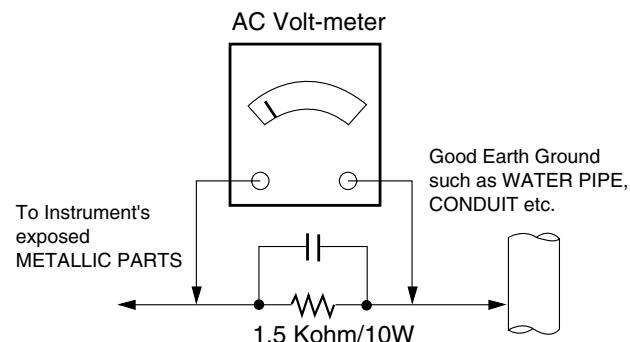
Note : It is important to use an accurate high voltage meter calibrated periodically.

- To measure the high voltage, use a high impedance high voltage meter, connect (-) to chassis and (+) to the CDT anode cap.
- Set the brightness control to maximum point at full white pattern.
- Measure the high voltage. The high voltage meter should be indicated at the factory recommended level.
- If the meter indication exceeds the maximum level, immediate service is required to prevent the possibility of premature component failure.
- To prevent X-radiation possibility, it is essential to use the specified picture tube.

CAUTION:

Please use only a plastic screwdriver to protect yourself from shock hazard during service operation.

Leakage Current Hot Check Circuit



SERVICING PRECAUTIONS

CAUTION: Before servicing receivers covered by this service manual and its supplements and addenda, read and follow the **SAFETY PRECAUTIONS** on page 3 of this publication.

NOTE: If unforeseen circumstances create conflict between the following servicing precautions and any of the safety precautions on page 3 of this publication, always follow the safety precautions. Remember: Safety First.

General Servicing Precautions

1. Always unplug the receiver AC power cord from the AC power source before;
 - a. Removing or reinstalling any component, circuit board module or any other receiver assembly.
 - b. Disconnecting or reconnecting any receiver electrical plug or other electrical connection.
 - c. Connecting a test substitute in parallel with an electrolytic capacitor in the receiver.
- CAUTION:** A wrong part substitution or incorrect polarity installation of electrolytic capacitors may result in an explosion hazard.
- d. Discharging the picture tube anode.
2. Test high voltage only by measuring it with an appropriate high voltage meter or other voltage measuring device (DVM, FETVOM, etc) equipped with a suitable high voltage probe.
Do not test high voltage by "drawing an arc".
3. Discharge the picture tube anode only by (a) first connecting one end of an insulated clip lead to the degaussing or kine aquadag grounding system shield at the point where the picture tube socket ground lead is connected, and then (b) touch the other end of the insulated clip lead to the picture tube anode button, using an insulating handle to avoid personal contact with high voltage.
4. Do not spray chemicals on or near this receiver or any of its assemblies.
5. Unless specified otherwise in this service manual, clean electrical contacts only by applying the following mixture to the contacts with a pipe cleaner, cotton-tipped stick or comparable non-abrasive applicator; 10% (by volume) Acetone and 90% (by volume) isopropyl alcohol (90%-99% strength)
CAUTION: This is a flammable mixture.
Unless specified otherwise in this service manual, lubrication of contacts is not required.
6. Do not defeat any plug/socket B+ voltage interlocks with which receivers covered by this service manual might be equipped.
7. Do not apply AC power to this instrument and/or any of its electrical assemblies unless all solid-state device heat sinks are correctly installed.
8. Always connect the test receiver ground lead to the receiver chassis ground before connecting the test receiver positive lead.
Always remove the test receiver ground lead last.

9. Use with this receiver only the test fixtures specified in this service manual.

CAUTION: Do not connect the test fixture ground strap to any heat sink in this receiver.

Electrostatically Sensitive (ES) Devices

Some semiconductor (solid-state) devices can be damaged easily by static electricity. Such components commonly are called *Electrostatically Sensitive (ES) Devices*. Examples of typical ES devices are integrated circuits and some field-effect transistors and semiconductor "chip" components. The following techniques should be used to help reduce the incidence of component damage caused by static by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed to prevent potential shock reasons prior to applying power to the unit under test.
2. After removing an electrical assembly equipped with ES devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
3. Use only a grounded-tip soldering iron to solder or unsolder ES devices.
4. Use only an anti-static type solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ES devices.
5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ES devices.
6. Do not remove a replacement ES device from its protective package until immediately before you are ready to install it. (Most replacement ES devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive material).
7. Immediately before removing the protective material from the leads of a replacement ES device, touch the protective material to the chassis or circuit assembly into which the device will be installed.
CAUTION: Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.
8. Minimize bodily motions when handling unpackaged replacement ES devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ES device.)

General Soldering Guidelines

1. Use a grounded-tip, low-wattage soldering iron and appropriate tip size and shape that will maintain tip temperature within the range of 500°F to 600°F.
2. Use an appropriate gauge of RMA resin-core solder composed of 60 parts tin/40 parts lead.
3. Keep the soldering iron tip clean and well tinned.
4. Thoroughly clean the surfaces to be soldered. Use a small wire-bristle (0.5 inch, or 1.25cm) brush with a metal handle.
Do not use freon-propelled spray-on cleaners.
5. Use the following unsoldering technique
 - a. Allow the soldering iron tip to reach normal temperature.
(500°F to 600°F)
 - b. Heat the component lead until the solder melts.
 - c. Quickly draw the melted solder with an anti-static, suction-type solder removal device or with solder braid.
- CAUTION:** Work quickly to avoid overheating the circuitboard printed foil.
6. Use the following soldering technique.
 - a. Allow the soldering iron tip to reach a normal temperature (500°F to 600°F)
 - b. First, hold the soldering iron tip and solder the strand against the component lead until the solder melts.
 - c. Quickly move the soldering iron tip to the junction of the component lead and the printed circuit foil, and hold it there only until the solder flows onto and around both the component lead and the foil.
- CAUTION:** Work quickly to avoid overheating the circuit board printed foil.
- d. Closely inspect the solder area and remove any excess or splashed solder with a small wire-bristle brush.

IC Remove/Replacement

Some chassis circuit boards have slotted holes (oblong) through which the IC leads are inserted and then bent flat against the circuit foil. When holes are the slotted type, the following technique should be used to remove and replace the IC. When working with boards using the familiar round hole, use the standard technique as outlined in paragraphs 5 and 6 above.

Removal

1. Desolder and straighten each IC lead in one operation by gently prying up on the lead with the soldering iron tip as the solder melts.
2. Draw away the melted solder with an anti-static suction-type solder removal device (or with solder braid) before removing the IC.

Replacement

1. Carefully insert the replacement IC in the circuit board.
2. Carefully bend each IC lead against the circuit foil pad and solder it.
3. Clean the soldered areas with a small wire-bristle brush. (It is not necessary to reapply acrylic coating to the areas).

"Small-Signal" Discrete Transistor Removal/Replacement

1. Remove the defective transistor by clipping its leads as close as possible to the component body.
2. Bend into a "U" shape the end of each of three leads remaining on the circuit board.
3. Bend into a "U" shape the replacement transistor leads.
4. Connect the replacement transistor leads to the corresponding leads extending from the circuit board and crimp the "U" with long nose pliers to insure metal to metal contact then solder each connection.

Power Output, Transistor Device Removal/Replacement

1. Heat and remove all solder from around the transistor leads.
2. Remove the heat sink mounting screw (if so equipped).
3. Carefully remove the transistor from the heat sink of the circuit board.
4. Insert new transistor in the circuit board.
5. Solder each transistor lead, and clip off excess lead.
6. Replace heat sink.

Diode Removal/Replacement

1. Remove defective diode by clipping its leads as close as possible to diode body.
2. Bend the two remaining leads perpendicular y to the circuit board.
3. Observing diode polarity, wrap each lead of the new diode around the corresponding lead on the circuit board.
4. Securely crimp each connection and solder it.
5. Inspect (on the circuit board copper side) the solder joints of the two "original" leads. If they are not shiny, reheat them and if necessary, apply additional solder.

Fuse and Conventional Resistor Removal/Replacement

1. Clip each fuse or resistor lead at top of the circuit board hollow stake.
2. Securely crimp the leads of replacement component around notch at stake top.
3. Solder the connections.

CAUTION: Maintain original spacing between the replaced component and adjacent components and the circuit board to prevent excessive component temperatures.

Circuit Board Foil Repair

Excessive heat applied to the copper foil of any printed circuit board will weaken the adhesive that bonds the foil to the circuit board causing the foil to separate from or "lift-off" the board. The following guidelines and procedures should be followed whenever this condition is encountered.

At IC Connections

To repair a defective copper pattern at IC connections use the following procedure to install a jumper wire on the copper pattern side of the circuit board. (Use this technique only on IC connections).

1. Carefully remove the damaged copper pattern with a sharp knife. (Remove only as much copper as absolutely necessary).
2. carefully scratch away the solder resist and acrylic coating (if used) from the end of the remaining copper pattern.
3. Bend a small "U" in one end of a small gauge jumper wire and carefully crimp it around the IC pin. Solder the IC connection.
4. Route the jumper wire along the path of the out-away copper pattern and let it overlap the previously scraped end of the good copper pattern. Solder the overlapped area and clip off any excess jumper wire.

At Other Connections

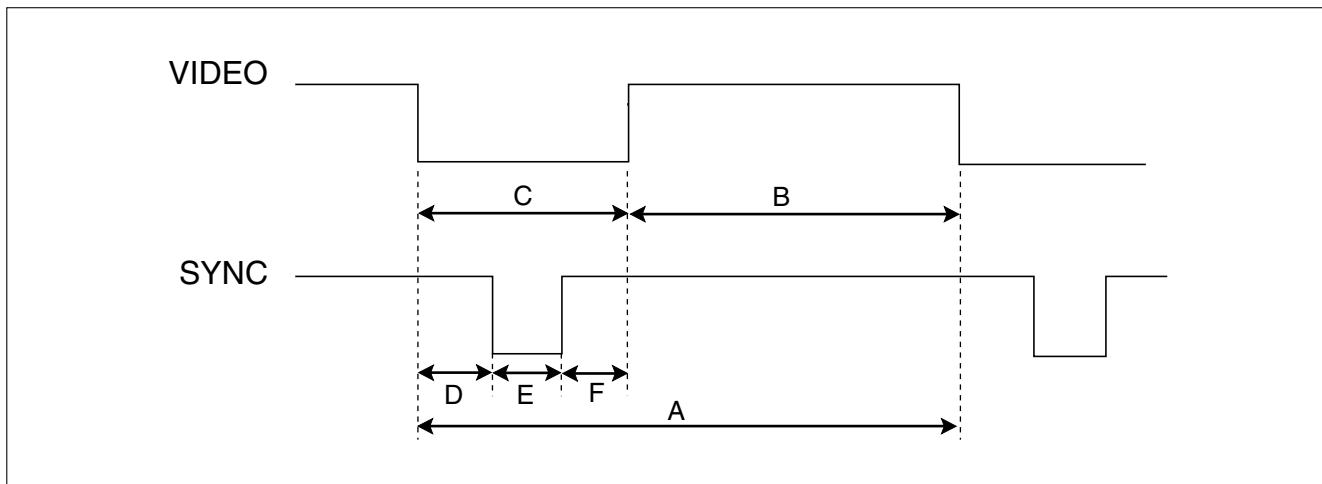
Use the following technique to repair the defective copper pattern at connections other than IC Pins. This technique involves the installation of a jumper wire on the component side of the circuit board.

1. Remove the defective copper pattern with a sharp knife.
Remove at least 1/4 inch of copper, to ensure that a hazardous condition will not exist if the jumper wire opens.
2. Trace along the copper pattern from both sides of the pattern break and locate the nearest component that is directly connected to the affected copper pattern.
3. Connect insulated 20-gauge jumper wire from the lead of the nearest component on one side of the pattern break to the lead of the nearest component on the other side.

Carefully crimp and solder the connections.

CAUTION: Be sure the insulated jumper wire is dressed so the it does not touch components or sharp edges.

TIMING CHART



<< Dot Clock (**MHz**), Horizontal Frequency (**kHz**), Vertical Frequency (**Hz**), Horizontal etc... (**μs**), Vertical etc... (**ms**) >>

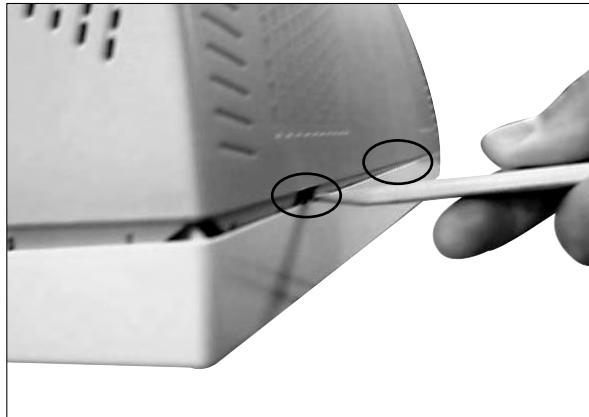
Mode	H/V Sort	Sync Polarity	Frequency	Total Period (A)	Video Active Time (B)	Blanking Time (C)	Sync Duration (E)	Back Porch (F)	Front Porch (D)	Resolution
1	H	—	37.50	26.67	20.32	6.35	2.03	3.81	0.51	640x480
	V	—	74.99	13.335	12.802	0.533	0.080	0.427	0.026	75Hz
2	H	+	46.88	21.33	16.16	5.17	1.62	3.23	0.32	800x600
	V	+	75.01	13.331	12.798	0.533	0.064	0.448	0.021	75Hz
3	H	+	53.68	18.63	14.22	4.41	1.14	2.70	0.57	800x600
	V	+	85.07	11.755	11.178	0.577	0.056	0.503	0.018	85Hz
4	H	+	68.677	14.561	10.836	3.725	1.016	2.201	0.508	1024x768
	V	+	85.00	11.764	11.182	0.582	0.044	0.524	0.014	85Hz

* No Support Composite Mode.

DISASSEMBLY



1. Carefully place the monitor on a soft cushion and stand it upright with the cabinet facing downward.
2. Remove the two screws from the back cover.



4. Separate the back cover from the latch at the bottom of the cabinet using the jig as shown in the figure.
(Insert the jig into the latch and lift slightly.)



3. Separate the back cover from the latch on top of the cabinet using a screwdriver as shown in the figure.
(Insert the screwdriver and gently press the latch.)



5. Lift up the back cover to separate from cabinet assembly.

ADJUSTMENT

1. Preparation for Service Adjustment

GENERAL INFORMATION

All adjustment are thoroughly checked and corrected when the monitor leaves the factory, but sometimes several adjustments may be required.

Adjustment should be following procedure and after warming up for a minimum of 30 minutes.

- Alignment appliances and tools.
 - IBM compatible PC.
 - Programmable Signal Generator.
(eg. VG-819 made by Astrodesign Co.)
 - EPROM or EEPROM with saved each mode data.
 - Alignment Adaptor and Software.
 - Digital Voltmeter.
 - White Balance Meter.
 - Luminance Meter.
 - High-voltage Meter.

AUTOMATIC AND MANUAL DEGAUSSING

The degaussing coil is mounted around the CDT so that automatic degaussing when turn on the monitor. But a monitor is moved or faced in a different direction, become poor color purity cause of CDT magnetized, then press DEGAUSSING on the OSD menu.

ADJUSTMENT PROCEDURE & METHOD

- Install the cable for adjustment such as Figure 1 and run the alignment program on the DOS for IBM compatible PC.
- Set external Brightness and Contrast volume to max position.

1. Adjustment for B⁺ Voltage.

- 1) Display cross hatch pattern at Mode 4.
- 2) Check D961 cathode voltage within $50V \pm 1V$.

2. Adjustment for High-Voltage.

- 1) Display cross hatch pattern at Mode 4.
- 2) Enter the SVC SUB menu as the following instruction.
- 3) Adjust H/Voltage to $25.8kV \pm 0.1 kV$ by adjust 1-P value.

2. Adjustment by Service Hot key

How to enter SVC HOT KEY

1. Press Menu and OSD window will appear.
2. While OSD window is displayed, ★★ is seen on the left bottom of OSD window.
3. Press ⌄ + power switch simultaneously and the screen will immediately refresh.
4. Press Menu and make sure that ★★ is changed to 1 2.
5. Follow the menu on the left of OSD window to find 12 and OSD will change as shown in the figure.
6. Select Degauss in the above figure and then press Select and ▶ to enter the screen of the SUB menu.
(Back Raster for Pattern)

FOS SPEC

1. Size

H : $310 \pm 4mm$

V : $230 \pm 4mm$

Scanning frequency : All Mode (Mode 1~4)

Display image : Cross hatch pattern

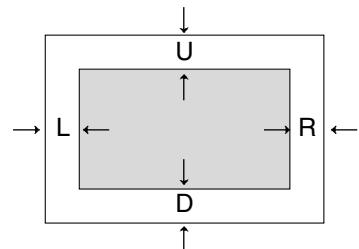
2. Centering

Scanning frequency : All Mode (Mode 1~4)

Display image : Crosshatch pattern

Horizontal : 10 Row

Vertical : 8 Row



H : | L-R | $\leq 4mm$, V : | U-D | $\leq 4mm$

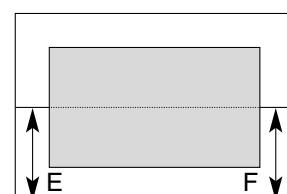
3. Tilt

Scanning frequency : All Mode (Mode 1~4)

Display image : Crosshatch pattern

Horizontal : 10 Row

Vertical : 8 Row



Tilt : | E-F | $\leq 2.0mm$

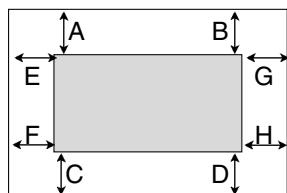
4. Distortion

Scanning frequency : All Mode (Mode 1~4)

Display image : Crosshatch pattern

Horizontal : 10 Row

Vertical : 8 Row



$$\begin{array}{l} |A-B| \leq 2.0\text{mm}, |C-D| \leq 2.0\text{mm} \\ |E-F| \leq 2.0\text{mm}, |G-H| \leq 2.0\text{mm} \end{array}$$

5. Dispala Size drift

- $\pm 4\text{mm}$: 25°C Standard, 10°C, 35°C
- $\pm 0.5\text{mm}$: 180V ~ 264V

6. Linearity

				Y1
				Y2
				Y3
				Y4
X1	X2	X3	X4	

Formula : $\{(Max - Min) / Max\} \times 100(\%)$

Criteria : H - 10% Max. (Upper 40kHz)

14% Max. (Less 40kHz)

V - 8% Max.

7. Regulation

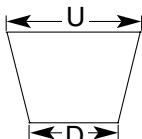
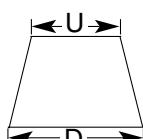
Luminance $\leq 2\text{mm}$

Dynamic(lode) $\leq 2\text{mm}$

Scanning frequency : All Mode (Mode 1~4)

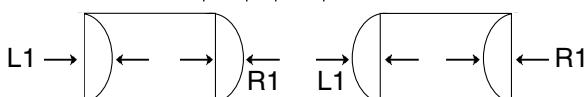
8. Trapezoid

$$|U-D| < 4\text{mm}$$

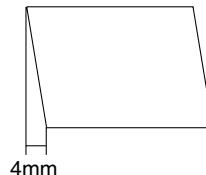


9. Pin Balance

$$|L1|, |R1| \leq 2.0\text{mm}$$



10. Parallelogram



11. Adjustment of white balance (Adjustment of chromaticity diagram)

*(Adjustment of white balance must be made after entering Hot Key Mode and DEGAUSS.)

CONDITIONS

Signal: 69 kHz / 85 Hz

Display image: Back raster (Color 0,0)

Contrast: Maximum

Brightness: Maximum

Color temperature: 9300K

11-1. Adjustment of cut off (Adjustment of back raster)

11-1(a). Before adjustment, press Menu and Degauss to remove.

=> Enter hot key mode.

Adjust Brightness and Contrast to Max in OSD window.

(1) Adjust cut off (back raster) first. Enter DEGAUSS in the Menu and modify the following data.

Modify RCUT to Min ,

Modify GCUT To Min ,

Adjust to BCUT Data = 127 (7F (h)) ,

Adjust to SBRT Data = 205 (CD (h)).

(2) Turn FBT screen volume on "CRT COLOR ANALYZER CA-100" equipment to adjust Brightness to $0.4 \pm 0.05\text{FL}$.

(3) Adjust RCUT, GCUT, and SBRT to set chromaticity diagram at :

x: 0.283 ± 0.005

y: 0.298 ± 0.005

Y: $0.40 \pm 0.05\text{FL}$

* If color values would not be matched desirable values, repeat sequence 1 and 2 after readjusting "GREEN CUTOFF" control a little different.

11-2. Adjustment of White Balance

After finishing adjustment of cut off (back raster), approve "Color(15.0) Full white pattern".

Adjust BDRV Data = 90, SCON=127.

Adjust RDRV and GDRV to set chromaticity diagram at :

x: 0.283 ± 0.005

y: 0.298 ± 0.005

Approve "Window pattern (70x70mm)" to adjust

S-CON to Y : 50 ± 1 FL.

Approve "Color (15.0) Full white pattern" again and adjust ABL Data to Y : 32 ± 1 FL

12. Focus Adjustment

CONDITIONS

Scanning frequency : All Mode (Mode 1~4)

Display image: "H" character pattern

Brightness: Cut off point

Contrast: Maximum

PROCEDURE

1. Adjust the Focus VR on the FBT to display the sharpest image possible.
2. Use Locktite to seal the Focus VR in position.

13. Color Purity Adjustment

Color purity is the absence of undesired color.

Conspicuous mislanding (unexpected color in a uniform field) within the display area shall not be visible at a distance of 50 cm from the CRT surface.

CONDITIONS

Orientation: Monitor facing east

Scanning Frequency: 1024 x 768@85Hz(69kHz/85Hz)

Display image: White flat field

Luminance: Cut off point at the center of the display area

Note: Color purity adjustments should only be attempted by qualified personnel.

PROCEDURE

For trained and experienced service technicians only.

Use the following procedure to correct minor color purity problems:

1. Make sure the display is not affected by external magnetic fields.
2. Very carefully break the glue seal between the 2-pole purity convergence magnets (PCM), the band and the spacer.
3. Make sure the spacing between the PCM assembly and the CRT stem is $29 \text{ mm} \pm 1 \text{ mm}$.
4. Display a green pattern over the entire display area.
5. Adjust the purity magnet rings on the PCM assembly to display a pure green pattern.
(Optimum setting: $x = 0.295 \pm 0.015$,
 $y = 0.594 \pm 0.015$)
6. Repeat steps 4 and 5 using a red pattern and then again, using a blue pattern.

Table 4-6. Color Purity Tolerances

Red:	$x=0.620 \pm 0.015$	$y=0.334 \pm 0.015$
Green:	$x=0.620 \pm 0.015$	$y=0.334 \pm 0.015$
Blue:	$x=0.620 \pm 0.015$	$y=0.334 \pm 0.015$

(For 9300K color adjustment: $x = 0.283 \pm 0.02$,
 $y = 0.298 \pm 0.02$)

7. When you have the PCMs properly adjusted, carefully glue them together to prevent their movement during shipping.

3. Adjustment Using Service software Program (Adjustment Program)

1. Adjustment for Factory Mode (Preset Mode).

- 1) Display cross hatch pattern at Mode All.
- 2) Run alignment program for 710BL/773NL on the IBM compatible PC.
- 3) EEPROM → ALL CLEAR → Y(Yes) command.
<Caution> Do not run this procedure unless the EEPROM is changed. All data in EEPROM (mode data and color data) will be erased.
- 4) COMMAND → PRESET START → Y(Yes) command.
- 5) DIST. ADJ. → FOS. ADJ command.
- 6) Adjust H-POSITION as arrow keys to center of the screen.
- 7) Adjust H-SIZE as arrow keys to 310 ± 2 mm.
- 8) Adjust V-POSITION as arrow keys to center of the screen.
- 9) Adjust V-SIZE as arrow keys to 230 ± 2 mm.
- 10) Adjust TRAPEZOID as arrow keys to be the best condition.
- 11) Adjust SIDE PINCUSHION as arrow keys to be the best condition.
- 12) Adjust TILT as arrow keys to be the best condition.
- 13) Display cross hatch pattern at Mode 4.
- 14) DIST. ADJ. → BALANCE DATA command.
- 15) Adjust balance of Pin-Balance as arrow keys to be the best condition.
- 16) Adjust parallelogram as arrow keys to be the best condition.
- 17) Save of the Mode.
- 18) Save of the System.
- 19) Display from Mode 4 and repeat above from number 6) to 16).
- 20) COMMAND → PRESET EXIT → Y (Yes) command.

2. Adjustment for White Balance and Luminance.

- 1) Set the White Balance Meter.
- 2) Press the DEGAUSSING on the OSD menu for demagnetization of the CDT.
- 3) Display color 0,0 pattern at Mode 4.
- 4) COMMAND → PRESET START → Y(Yes) command.
- 5) Set Brightness and Contrast to max position.
- 6) COLOR ADJ. → LUMINANCE command of the alignment program.
- 7) COLOR ADJ. → BIAS ADJ. command of the alignment program.
- 8) Check whether blue color or not at R-BIAS and G-BIAS to min position, Sub-Brightness to 205 (CD(h))position, B-Bias to 127(7F(h))position. If it's not blue color, the monitor must repair.
- 9) Adjust Screen control on the FBT to 0.4 ± 0.05 FL of the raster luminance.
- 10) Adjust R-BIAS and G-BIAS command to $x=0.283 \pm 0.006$ and $y=0.298 \pm 0.006$ on the White Balance Meter with PC arrow keys.
- 11) Display color 15,0 Full White(70x70mm) at mode 4.
- 12) DRIVE ADJ command.
- 13) Set B-DRIVE to 90(5A(h)) at DRIVE of the alignment program.
- 14) Adjust R-DRIVE and G-DRIVE command to white balance $x=0.283 \pm 0.003$ and $y=0.298 \pm 0.003$ on the White Balance Meter with PC arrow keys.
- 15) Adjust SUB-CONTRAST command to 50 ± 1 FL of the raster luminance.
- 15) Display color 15,0 full white patten at Mode 4.
- 16) COLOR ADJ. → LUMINANCE → ABL command.
- 17) Adjust ABL to 32 ± 1 FL of the luminance.
- 18) Exit from the program.

- Adjustment and EDID Data Down in GCSC

Windows EDID V1.0 User Manual

Operating System: MS Windows 98, 2000, XP

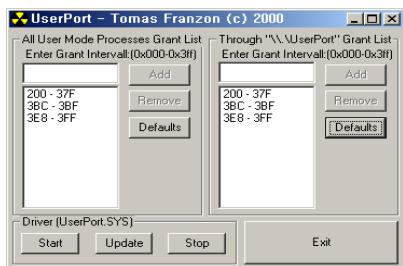
Port Setup: Windows 98 => Don't need setup

Windows 2000, XP => Need to Port Setup.

This program is available to LCD Monitor only.

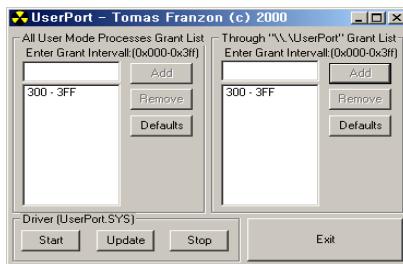
1. Port Setup

- Copy "UserPort.sys" file to
"c:\WINNT\system32\drivers" folder
- Run Userport.exe



- Remove all default number

- Add 300-3FF

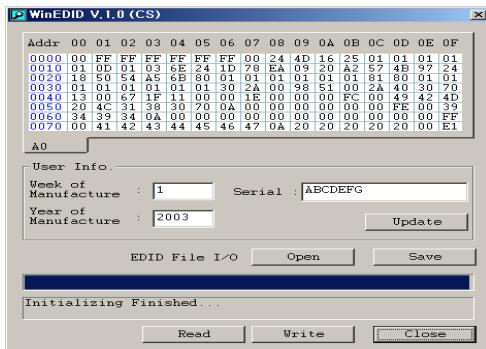


- Click Start button.

- Click Exit button.

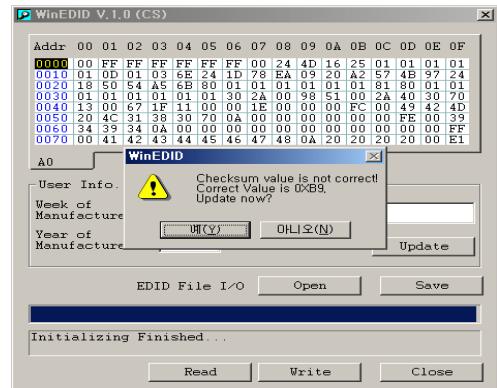
2. EDID Read & Write

1) Run WinEDID.exe



2) Edit Week of Manufacture, Year of Manufacture, Serial Number

- Input User Info Data
- Click "Update" button
- Click "Write" button



EDID DATA EDIT(710BL)

• "Changeable by Suffix"

No	Item	Content	16 진 Data
1	Manufacturer ID	GSM	1E6D
2	Product ID	17312	43A0
3	Year	2004	0E
4	Version	1	01
5	Revision	3	03
6	Model name	710B	37313042
7.	Special		

00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
00	00	FF	FF	FF	FF	FF	FF	00	1E	6D	A0	43 *	01	00	00
10	**01	0E	01	03	18	21	19	B7	EA	05	79	A0	56	4A	99
20	12	48	4C	FF	FE	80	31	59	71	4F	45	59	61	59	81
30	81	4A	01	01	01	01	EA	24	00	60	41	00	28	30	60
40	13	00	36	E6	10	00	00	1E	00	00	00	FD	00	32	A0
50	47	0B	0	0A	20	20	20	20	20	20	00	00	00	FC	00
60	31	30	42	0A	20	20	20	20	20	20	20	20	00	00	FC
70	00	0A	20	20	20	20	20	20	20	20	20	20	20	00	***

EDID DATA EDIT(773NL)

"Changeable by Suffix"

No.	项目	标示	16 进制数据
1	Manufacturer ID	GSM	1E6D
2	Product ID	17135	42EF
3	Year	2004	0E
4	Version	1	01
5	Revision	3	03
6	Model name	773N	3737334E

	O	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
O	O	FF	FF	FF	FF	FF	FF	O	1E	6D	# EF	# 42	*	*	*	*
1	** 7	*** 0E	1	3	18	21	19	B7	E8	E0	59	A1	54	46	9B	24
2	10	48	4C	FF	FE	80	31	4F	31	59	45	4F	45	59	61	4F
3	61	59	81	80	49	4F	EA	24	O	60	41	O	28	30	30	60
4	13	O	36	E6	10	O	O	1E	O	O	O	FD	O	32	A0	1E
5	47	OB	O	OA	20	20	20	20	20	20	O	O	O	FC	O	37
6	37	33	4E	OA	20	20	20	20	20	20	20	20	O	O	O	FC
7	O	OA	20	20	20	20	20	20	20	20	20	20	20	20	O	***

EDID Data Edit Using Service software Program

1 Read and Modify EDID Data

- 1) Connector the monitor and adjust device as Figure1
- 2) Display color 15,0 cross hatch pattern at Mode 4.
- 3) Use EDIT – MODEL SEL. command to select the right model info file.
- 4) Use EDIT – EDID INFO command and return to read the EDID Data.
- 5) Modify the EDID Data if needed and using F10 to save the change and exit.

2 Write EDID Data.

- 1) Display color 15,0 cross hatch pattern at Mode 4.
- 2) Use EEPROM – Write EDID command and confirm “EDID Write OK!!” message of monitor.
- 3) Exit from the alignment program.
- 4) Power switch OFF/ON for EDID data save.

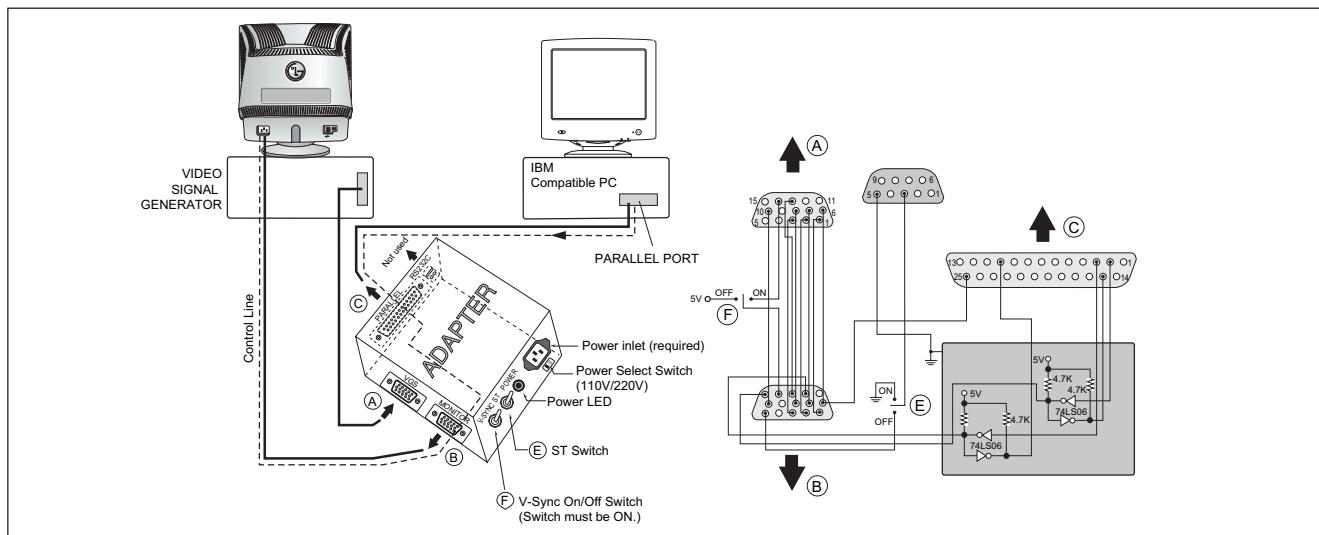
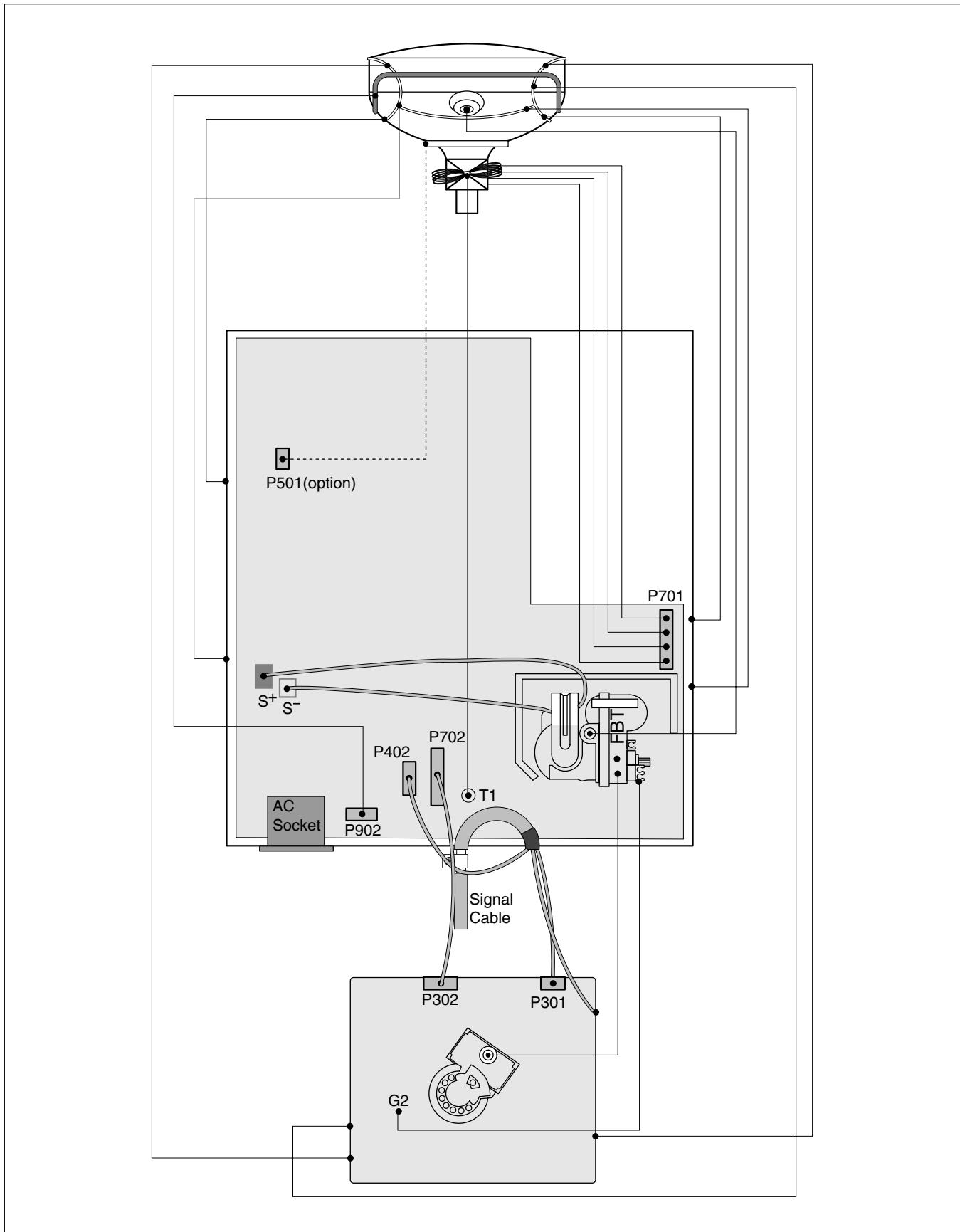
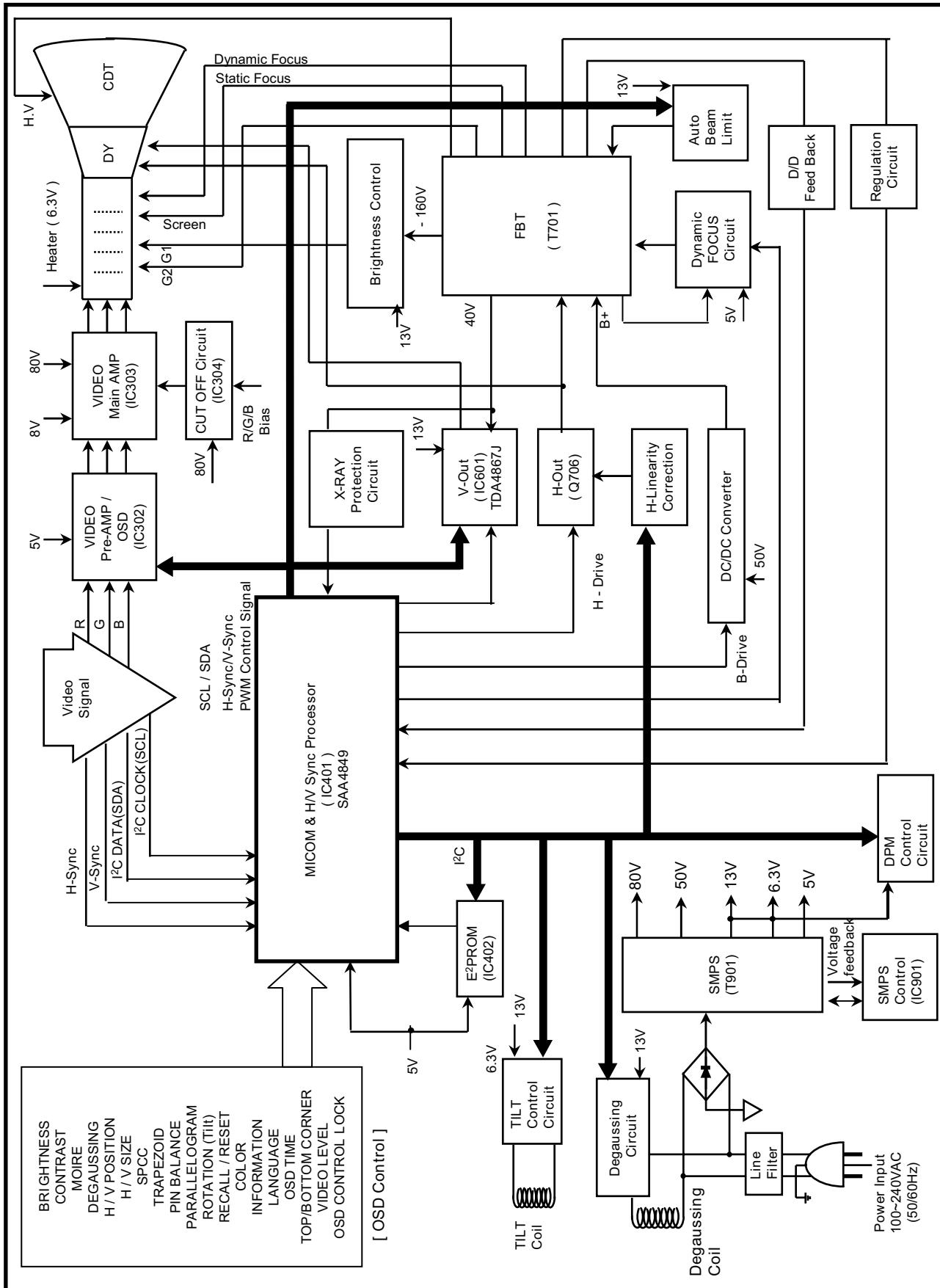


Figure 1. Cable Connection

WIRING DIAGRAM



BLOCK DIAGRAM



DESCRIPTION OF BLOCK DIAGRAM

1. SMPS(Switching Mode Power Supply)

When you turn on the power switch, the operating procedure is as follows:

- 1) The AC line voltage is rectified by the bridge diode D900.
- 2) The control IC(IC901) starts switching and generates switch pulse in the primary turn of the SMPS transformer(T901)
- 3) The switching pulses of the primary turns are induced to the secondary turns of the transformer by the turn ratio. This pulses are rectified by each diode(D971, D961(D962),D951,D942,D941)
- 4) Each rectified DC voltage(80V, 50V, 13V, 6.3V and 5V)

2. Over Voltage Protection Circuit

When the input of IC901 Vin (pin 4) is more than 22V, all the secondary voltages of the SMPS transformer (T901) down to low value

3. Display Power Management Circuit(DPM)

1) STAND-BY & SUSPEND Mode

When no input of horizontal or vertical sync Q951, Q941 are turned off and Q952,Q942 are turned off. Then input power consumption is below 5 watts.

2) OFF Mode

When no input of horizontal and vertical sync Q951, Q941 are turned off and Q952, Q942 are turned off. Then input power consumption is below 5 watts.

4. Microprocessor Control & Horizontal and Vertical Sync Processor Circuit

The operating procedure is as follows :

- 1) There is Horizontal & Vertical process function in Microprocessor.(IC401)
- 2) Microprocessor (IC401) discriminates the operating mode from the sync polarity and resolution.
- 3) After microprocessor reads these adjusted mode data stored at EEPROM, it controls operating mode data through IIC
- 4) Users can control screen condition by the OSD Select, Up, Down, Left, Right, Exit.
- 5) The horizontal and vertical sync processor IC (IC401) has a sync detector, a saw-tooth generator, and drive function, And outputs horizontal and vertical drive signal to control screen distortions

5. D/D Converter Circuit

To obtain constant high voltage, this circuit supplies controlled DC voltage for FBT and horizontal deflection circuit according to the horizontal sync frequency.

6. X-RAY Protection Circuit

When the high Voltage reaches to 29kV in an abnormal case, the high voltage detector circuit, R818,D721,C739-1 R416, C409 start operation to shut down high voltage circuit.

7. Horizontal S-correction Circuit.

This circuit corrects the horizontal linearity for each horizontal sync frequency.

8. Horizontal drive and Output Circuit.

This circuit is a horizontal deflection amplifier for raster scan.

9. ABL Circuit

This circuit limits the beam-current for the reliability of CDT

10. Vertical Output Circuit

This circuit takes the vertical ramp wave from the TDA4867J (IC601) and perform the vertical deflection by supplying the saw-tooth wave current to the vertical deflection yoke.

11. Blanking and Brightness Control Circuit.

Blanking circuit eliminates the retrace line by supplying a negative pulse wave to the G1 of the CDT. Brightness control circuit is used for control of the screen brightness by changing the DC level G1.

12. Image Rotation (Tilt) Circuit

This circuit corrects the tilt of the screen by supplying the image rotation signal to the tilt coil which is attached near the deflection yoke of the CDT

13. OSD (On Screen Display) Circuit

This circuit displays information of the monitor's status on the screen.

14. Video Processor Circuit.

Video processor circuit consists of the video drive output block. The video drive IC(IC302) receives the video signal from PC. The gain of each channel is controlled by MICOM through IIC. The cut-off circuit compensates different voltage of each channel between the cathode and the G1 of the CDT

15. Video Pre-Amp Circuit.

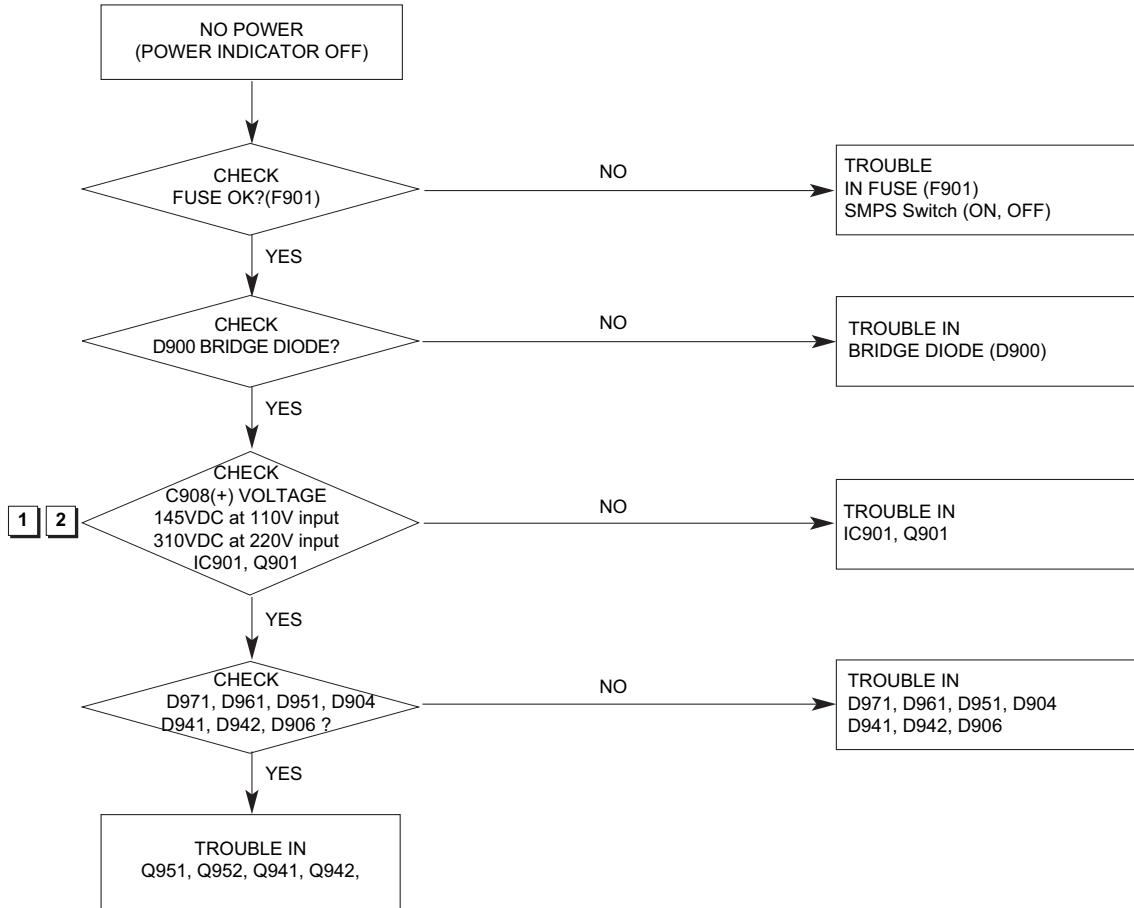
This circuit amplifies the analog video signal from 0~0.7 V to 0~4 V. It is operated by taking the clamp, R,G,B drive and contrast signal from the MICOM (IC401)

16. Video Output Amp Circuit.

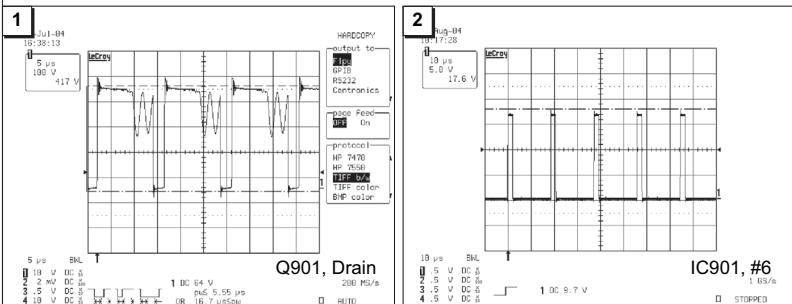
This circuit amplifies the video signal which comes from the video pre-amp circuit and amplified it to applied the CDT cathode

TROUBLESHOOTING GUIDE

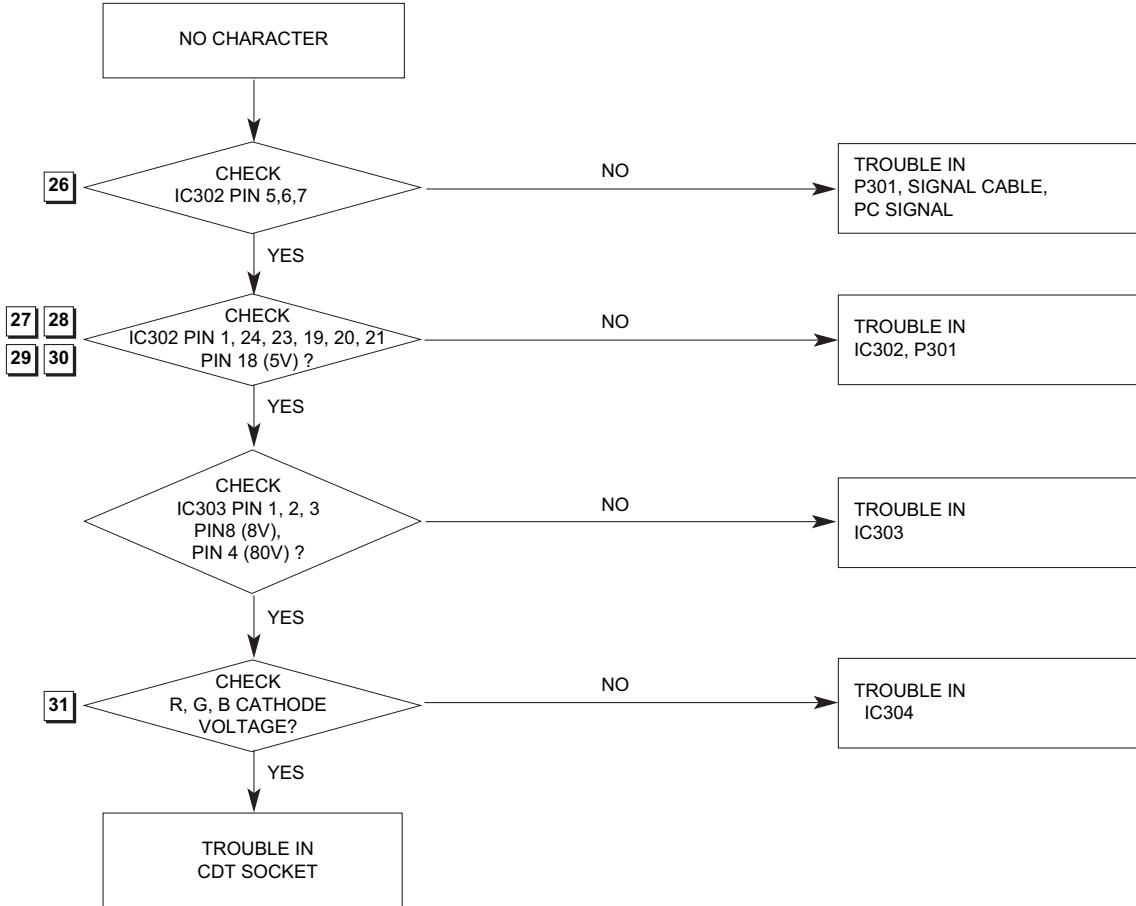
1. NO POWER



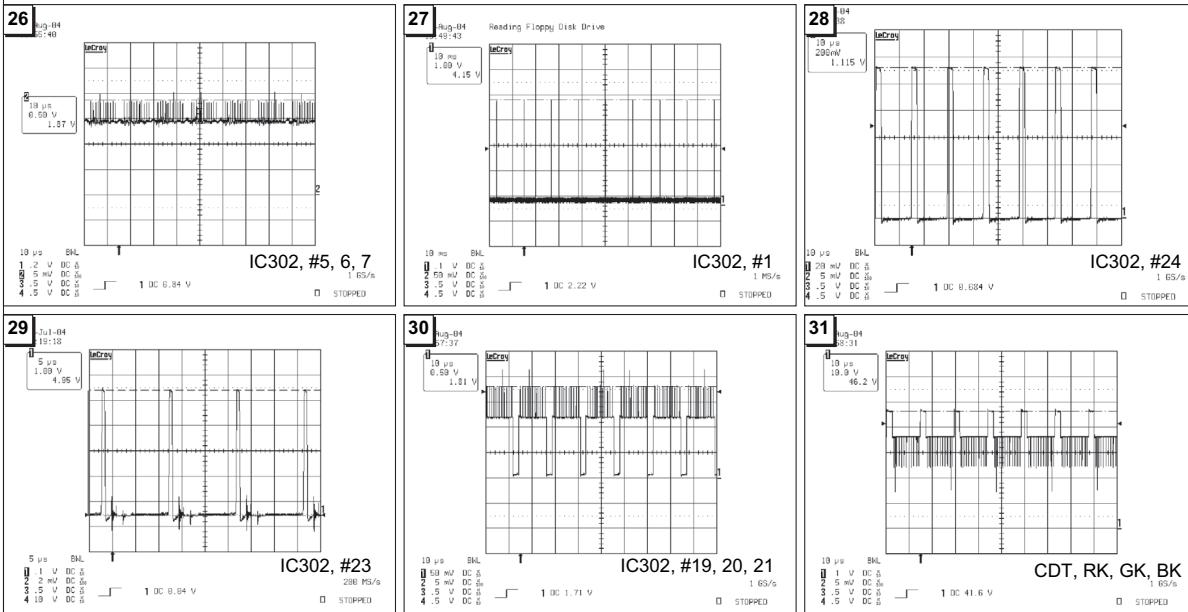
Waveforms



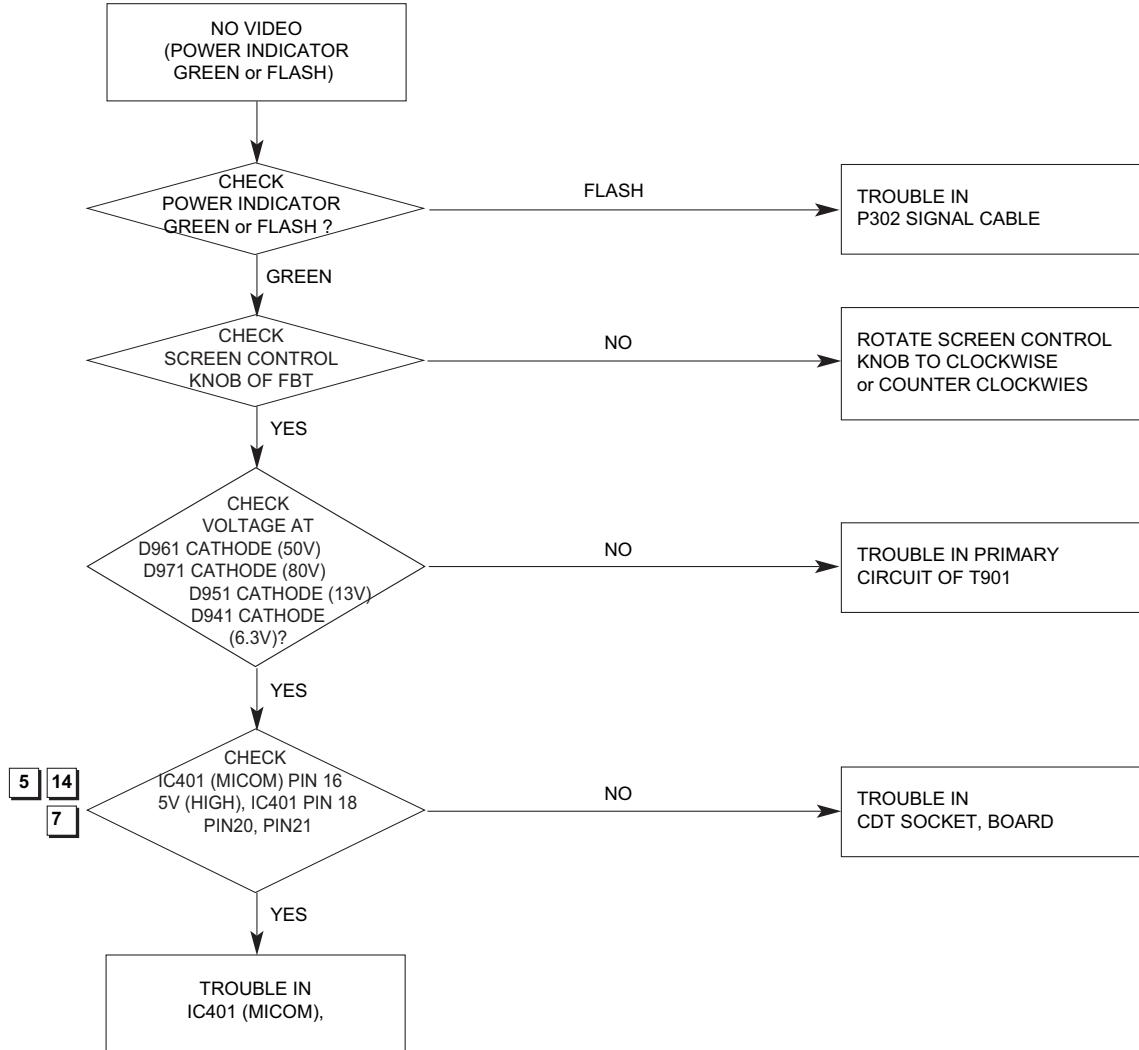
2. NO CHARACTER



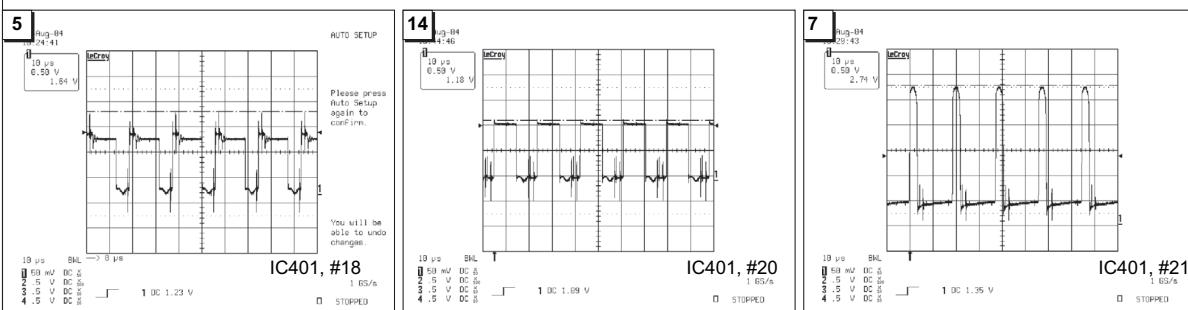
Waveforms



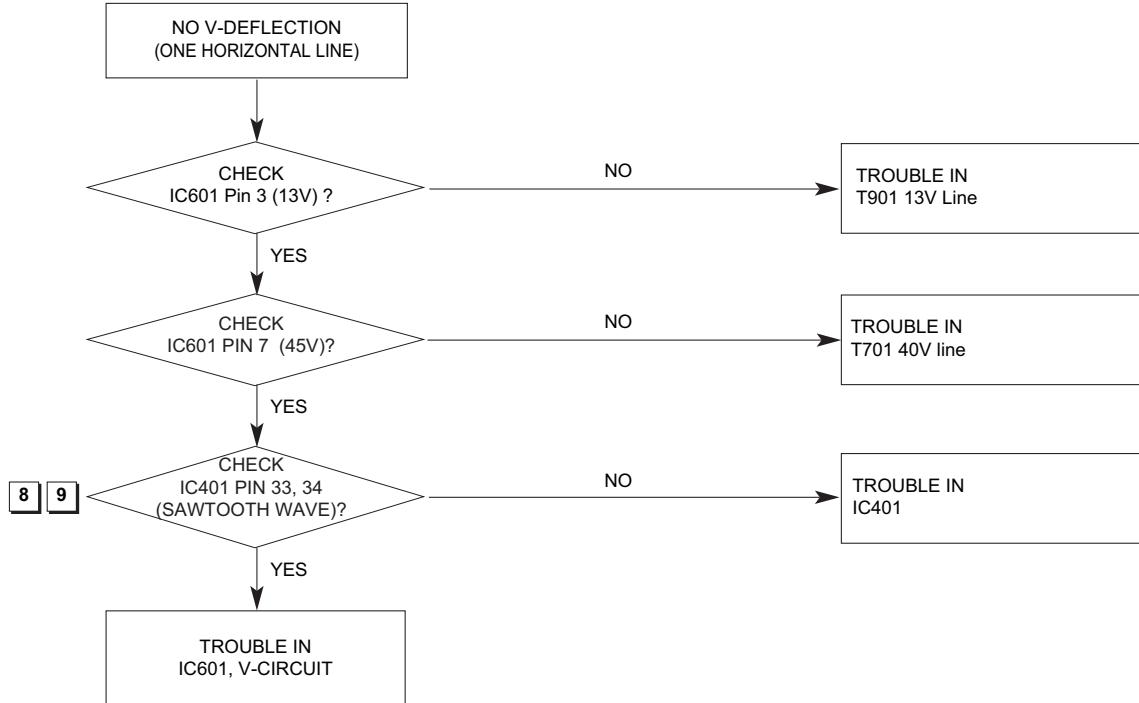
3. NO RASTER



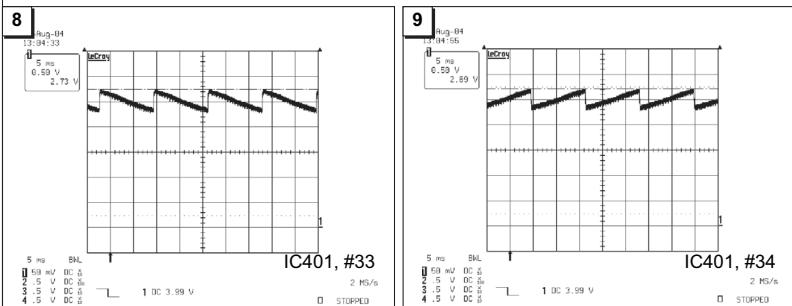
Waveforms



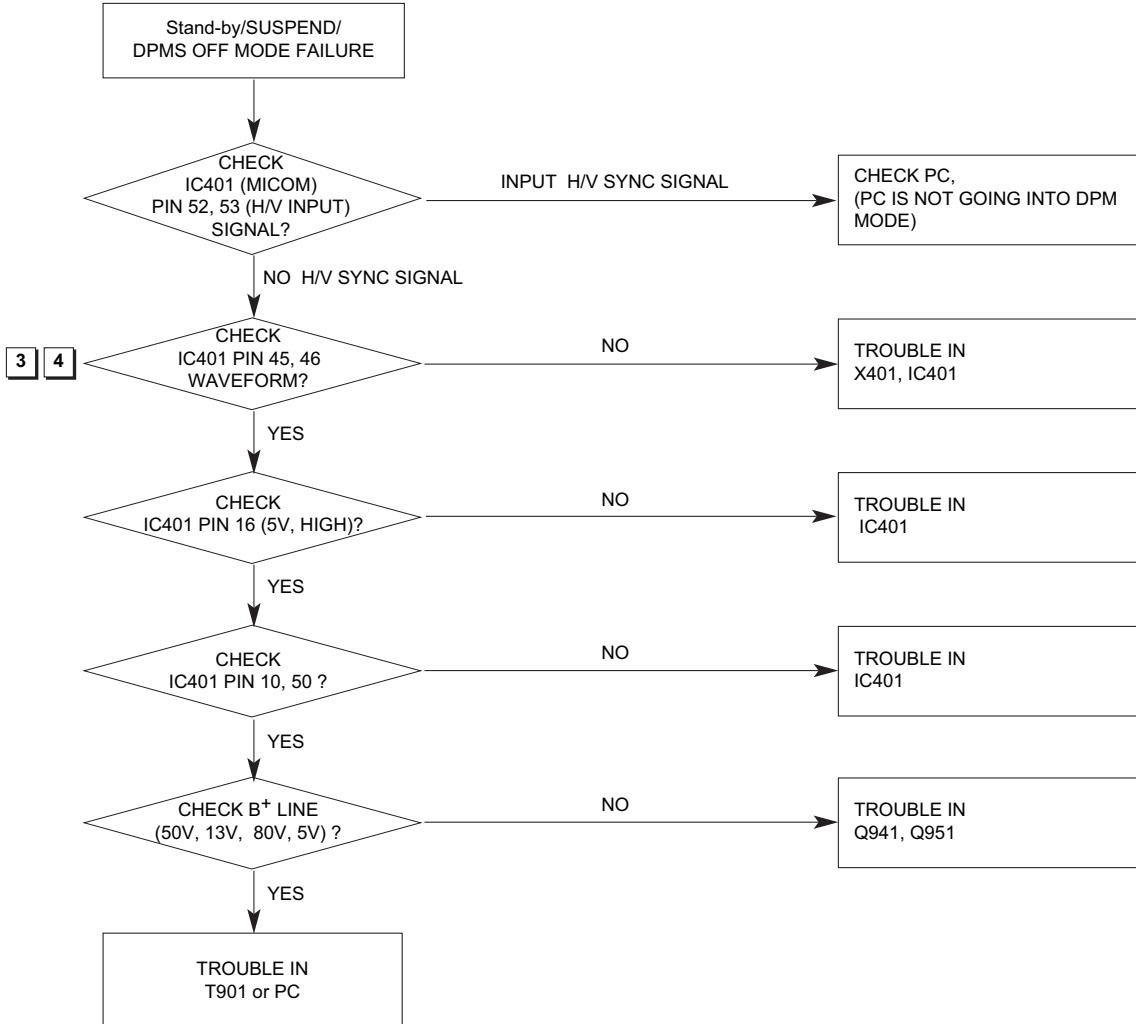
4. NO VERTICAL DEFLECTION



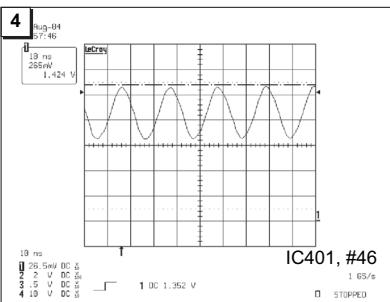
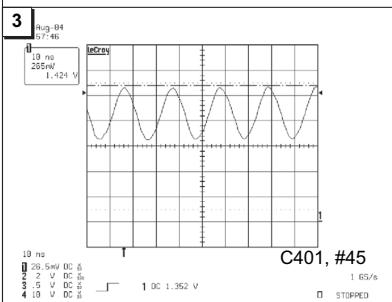
Waveforms



5. TROUBLE IN DPM



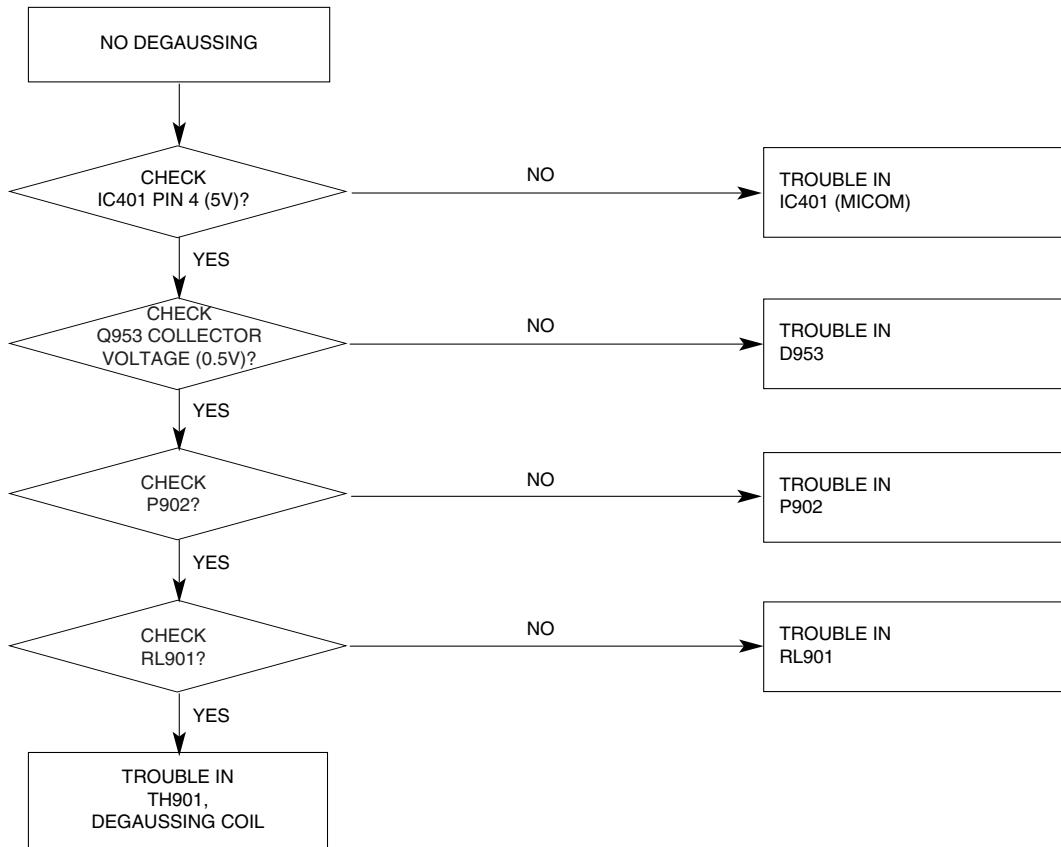
Waveforms



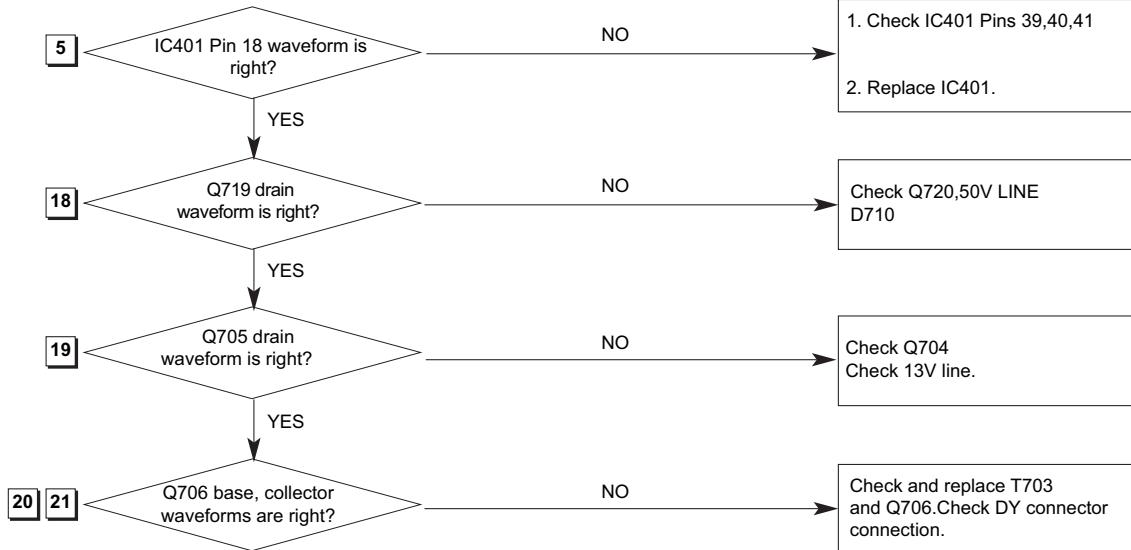
DPMS TABLE

ITEM MODE	H/V SYNC	VIDEO	LED
NORMAR	ON/ON	NORMAL	GREEN
STAND-BY	OFF/ON	OFF(0V)	FLASH
SUSPEND	ON/OFF	OFF(0V)	FLASH
OFF	OFF/OFF	OFF(0V)	FLASH

6. NO DEGAUSSING



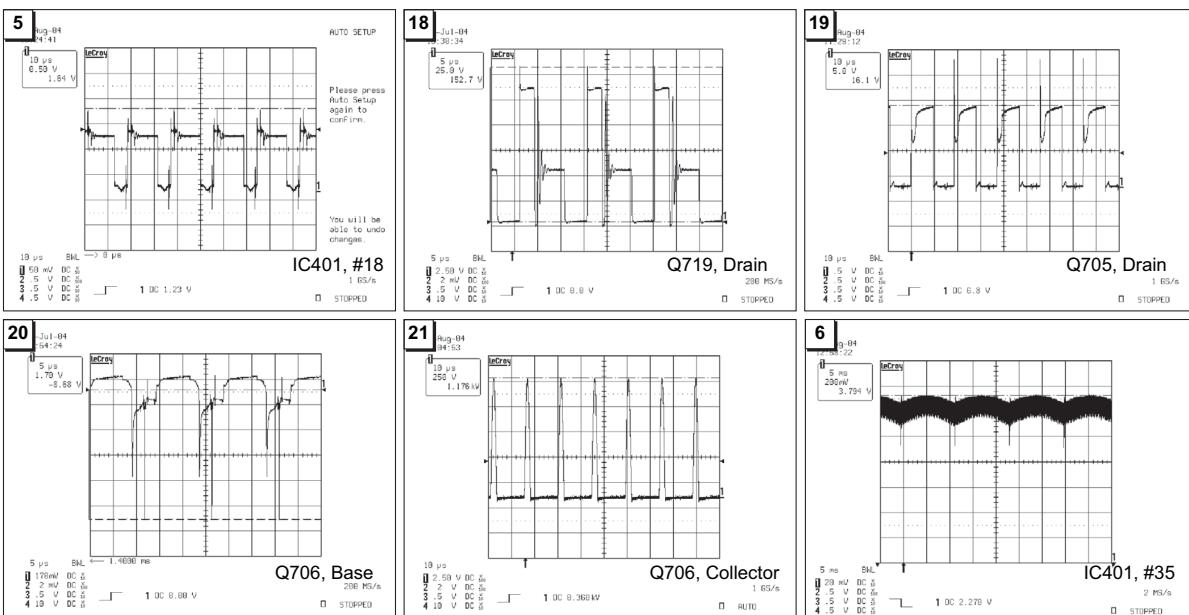
7. H_Deflection Failure



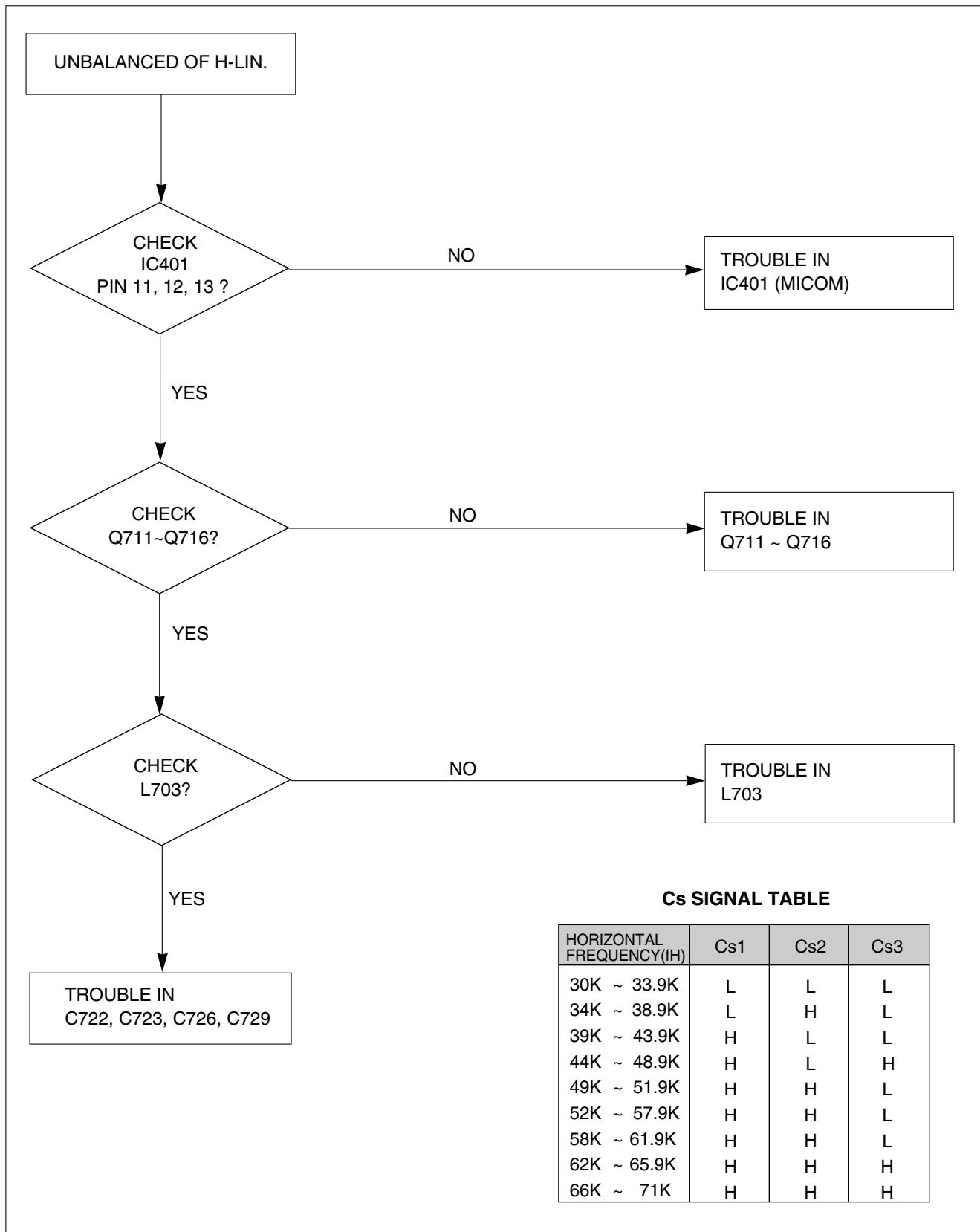
8. Invariable H_Size



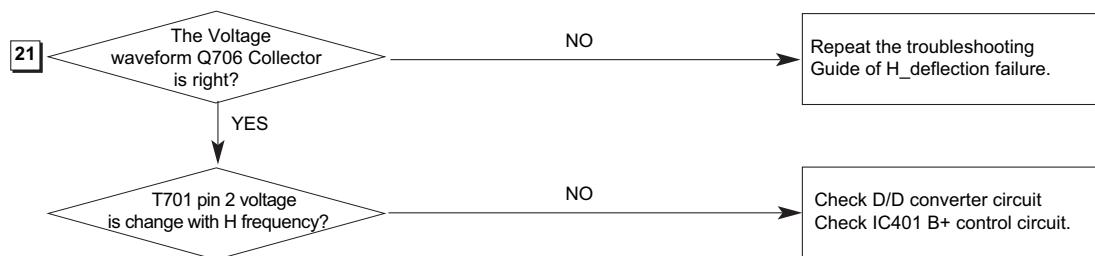
Waveforms



5. TROUBLE IN H-LINEARITY



11. Abnormal H_Size



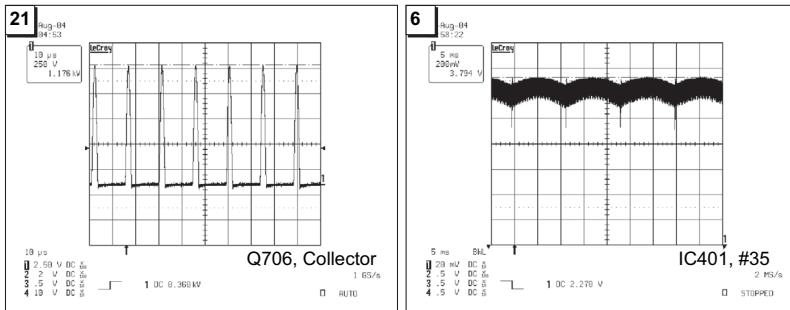
12. Side Pin or Trap Failure



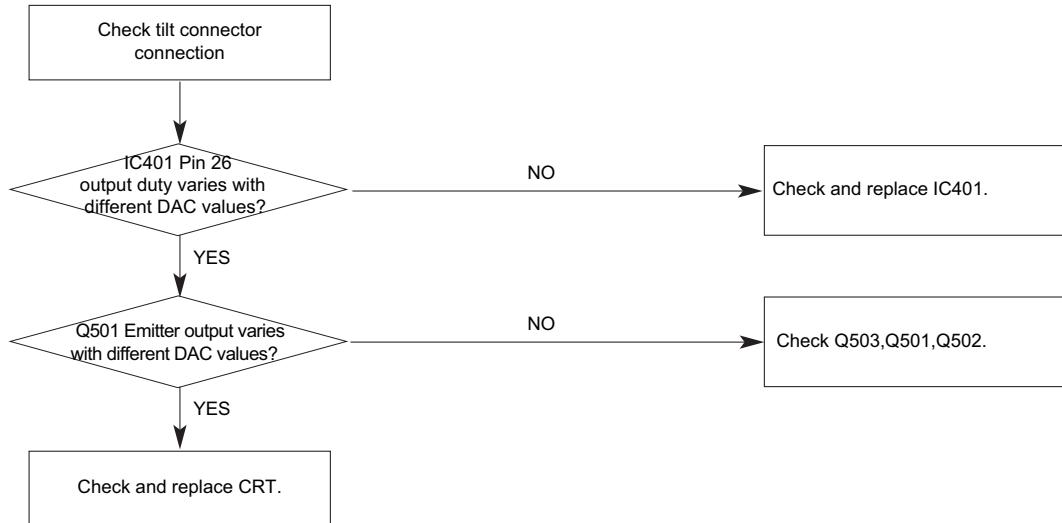
13. Para. or Pin Balance Failure

Replace IC401.

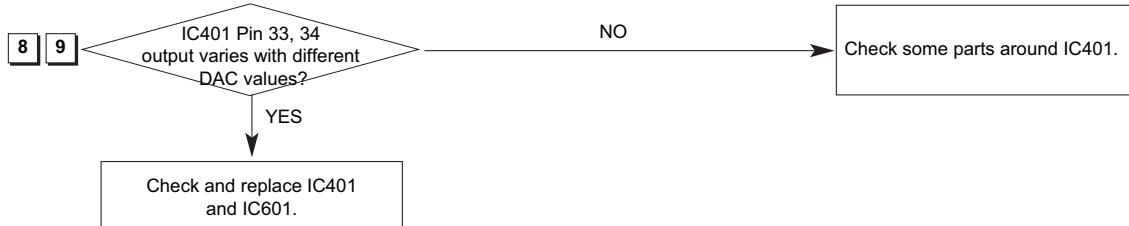
Waveforms



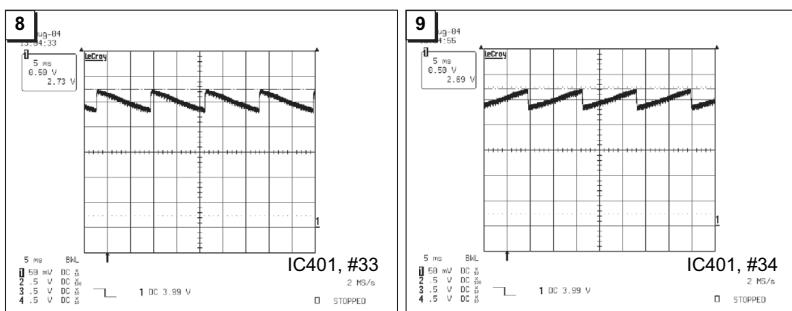
14. Tilt Failure



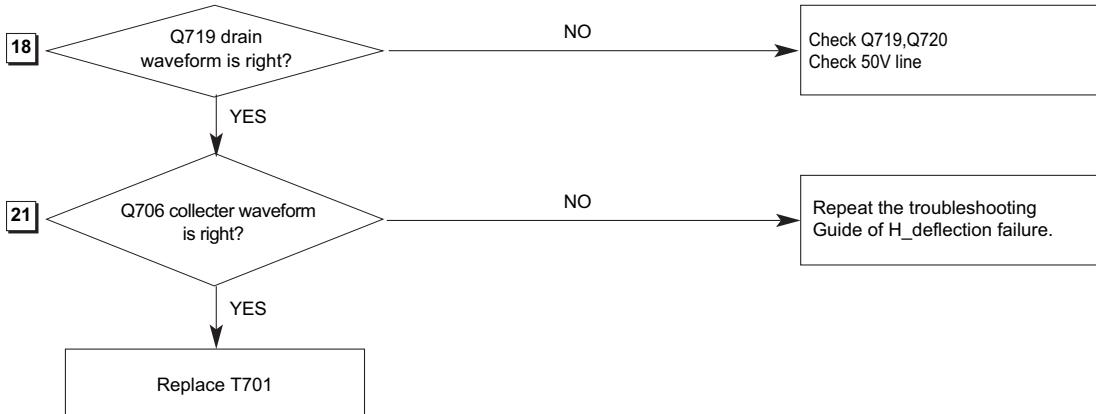
15. V Size or Pos. Variation Failure



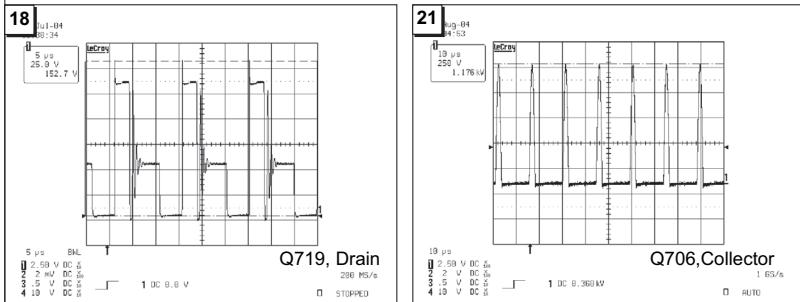
Waveforms



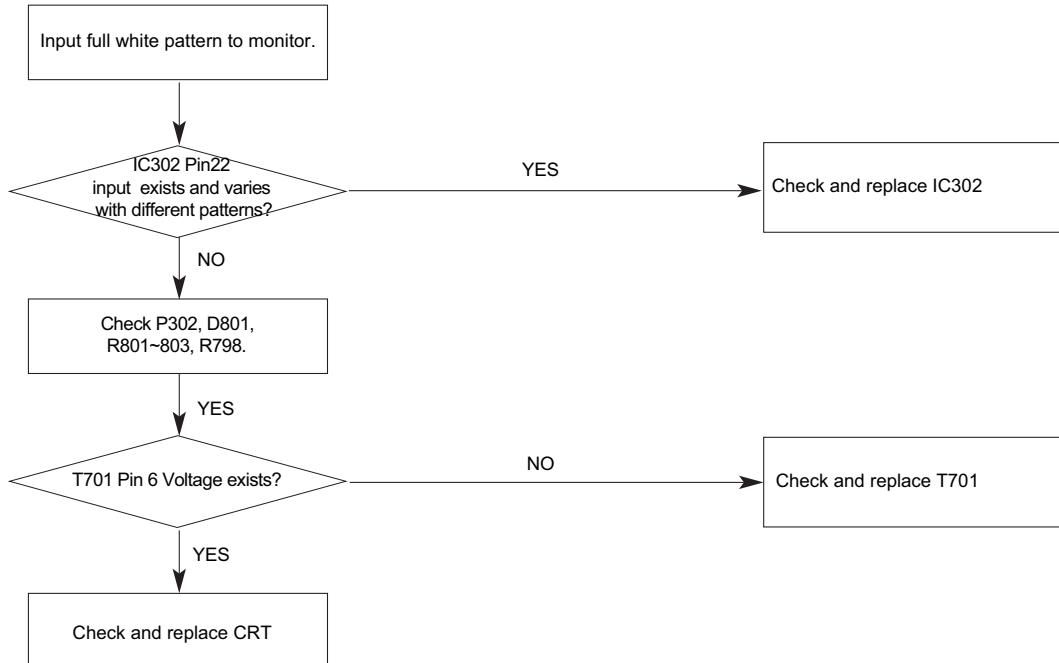
16. High Voltage Failure



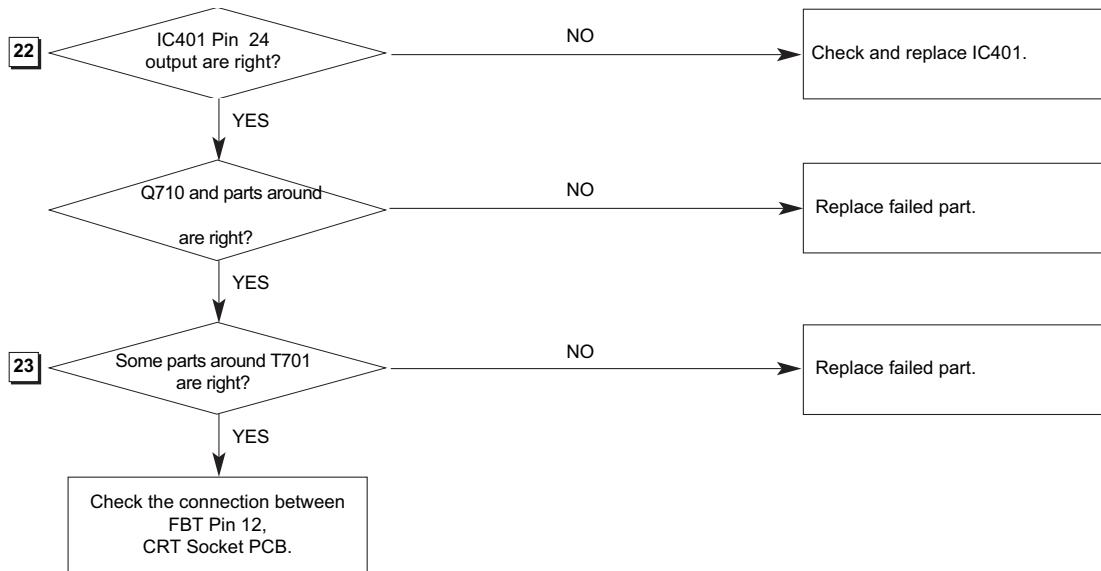
Waveforms



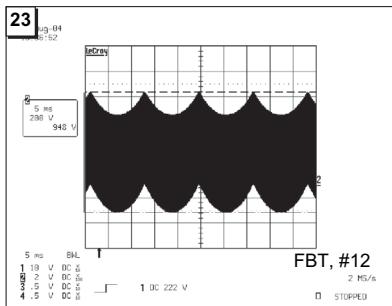
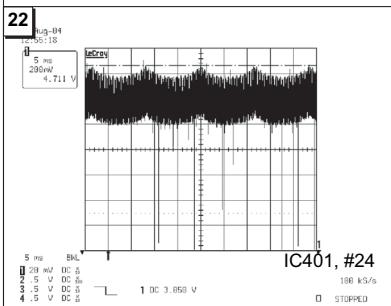
17. ABL Failure



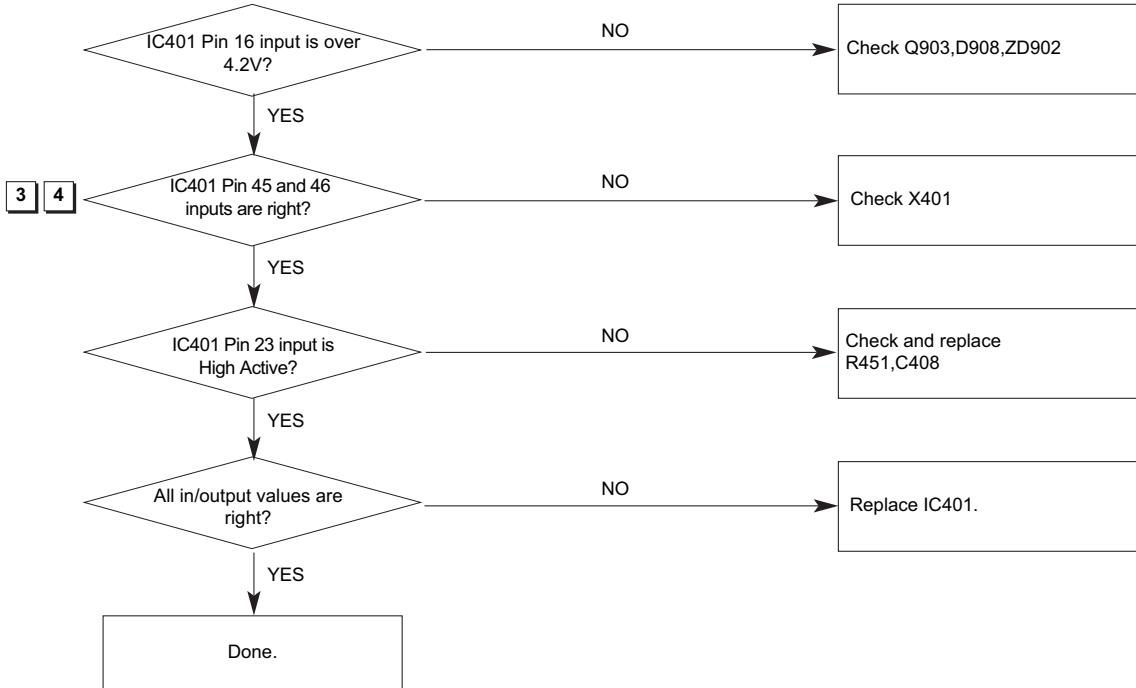
18. Focus Failure



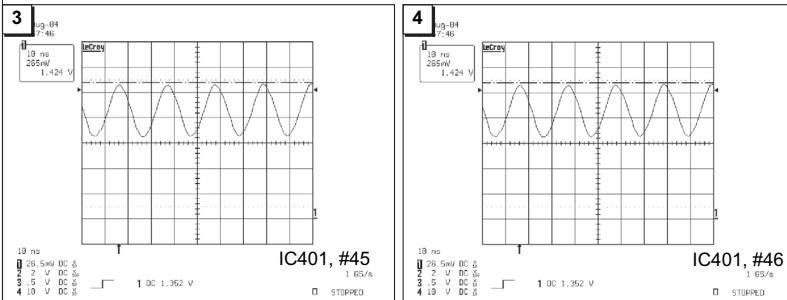
Waveforms



19. Micom Failure



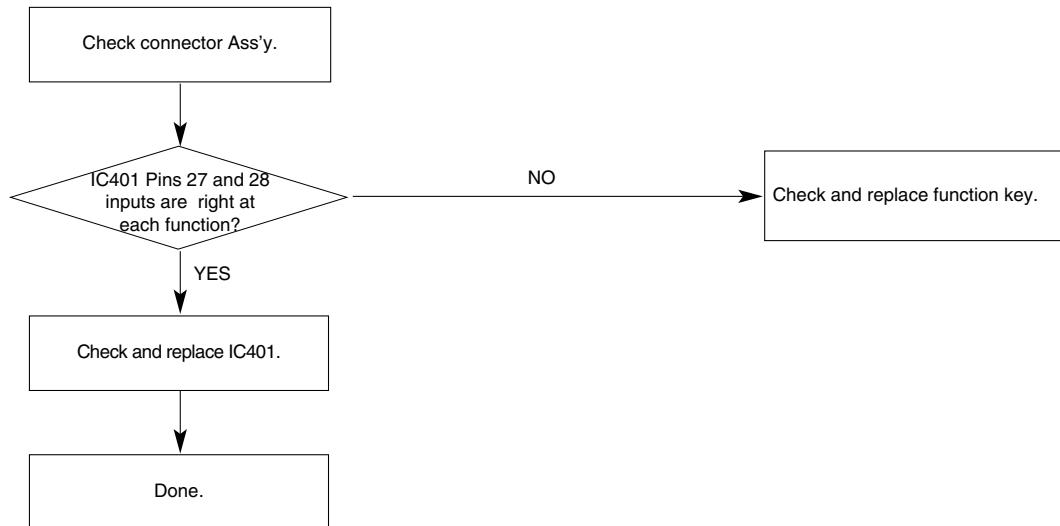
Waveforms



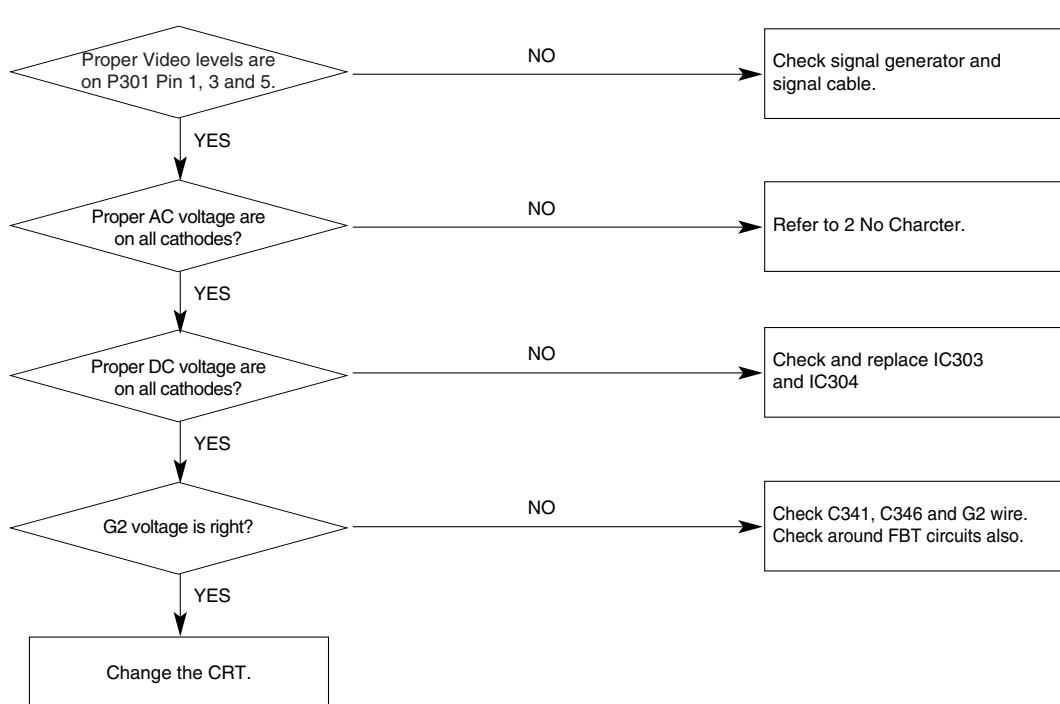
20. OSD Failure

Change IC302

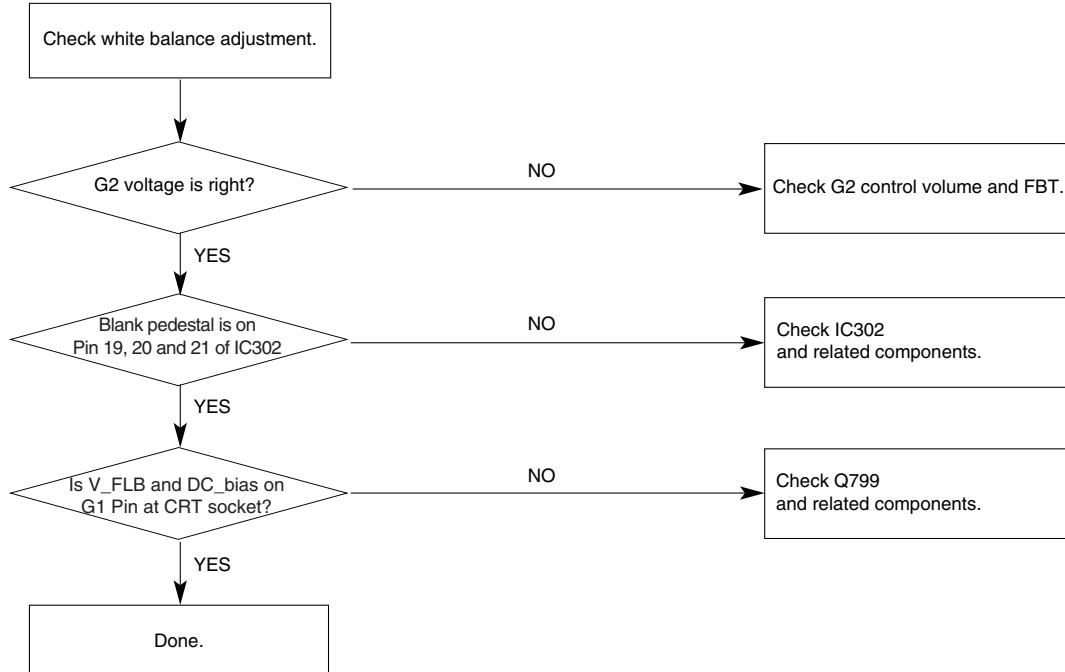
21. User Control Failure



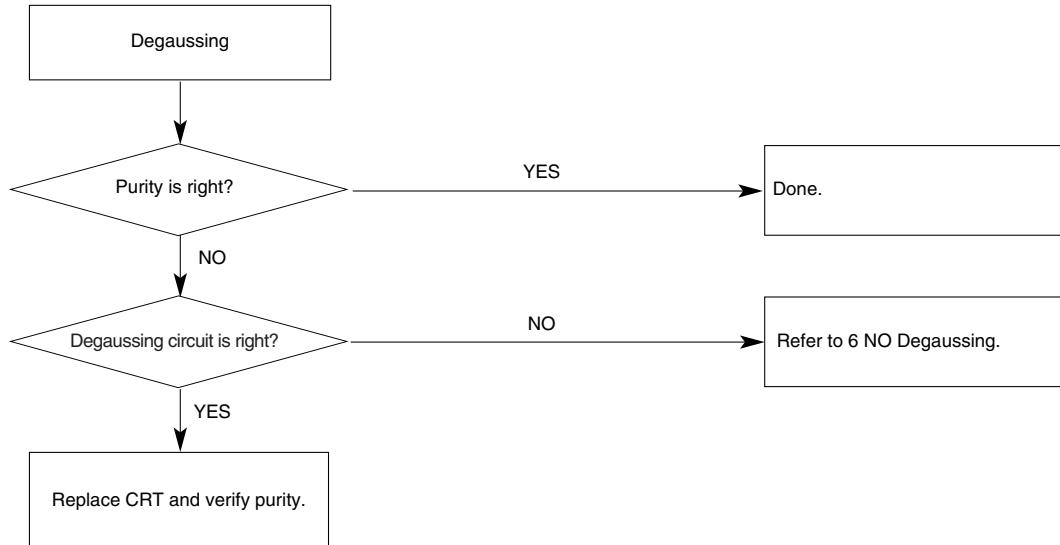
22. Missing Color



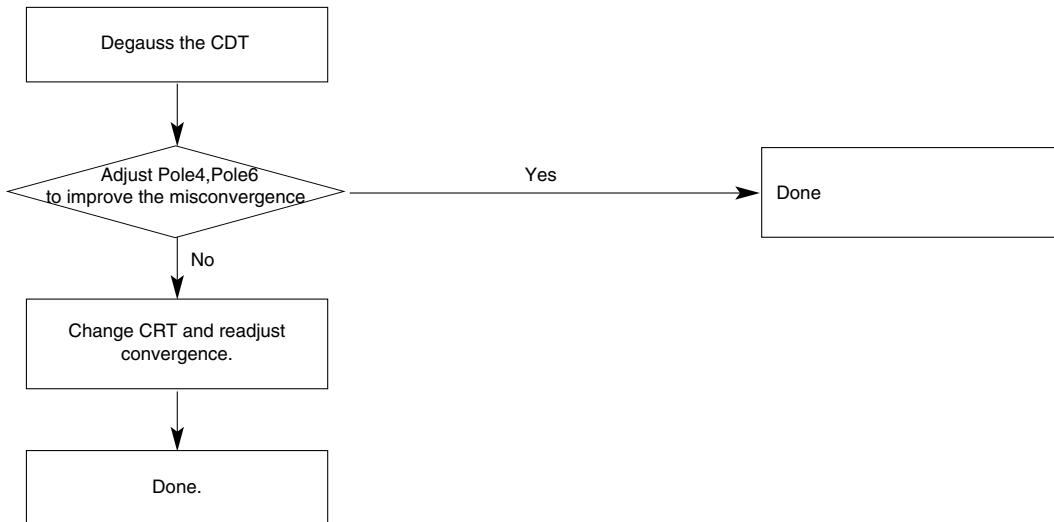
23. Visible Retrace



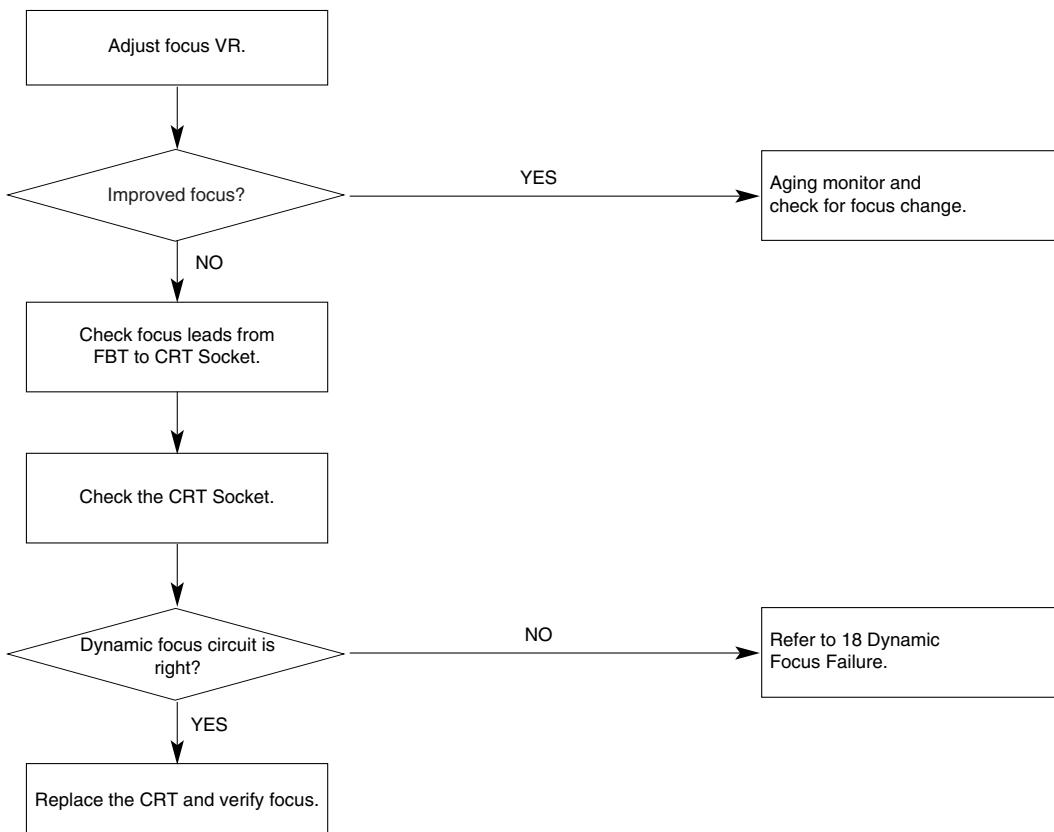
24. Purity Failure



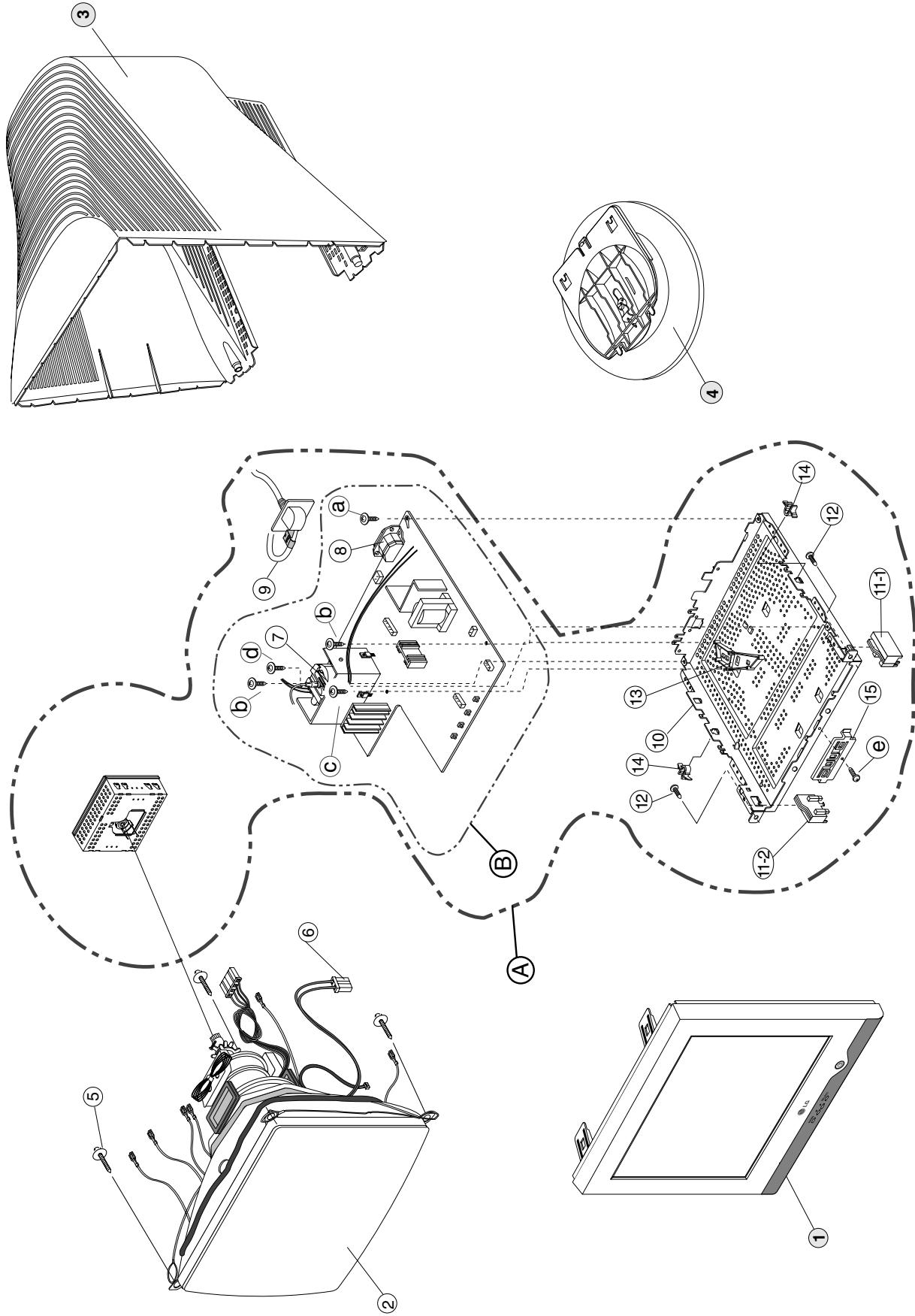
25. Misconvergence



26. Poor Focus



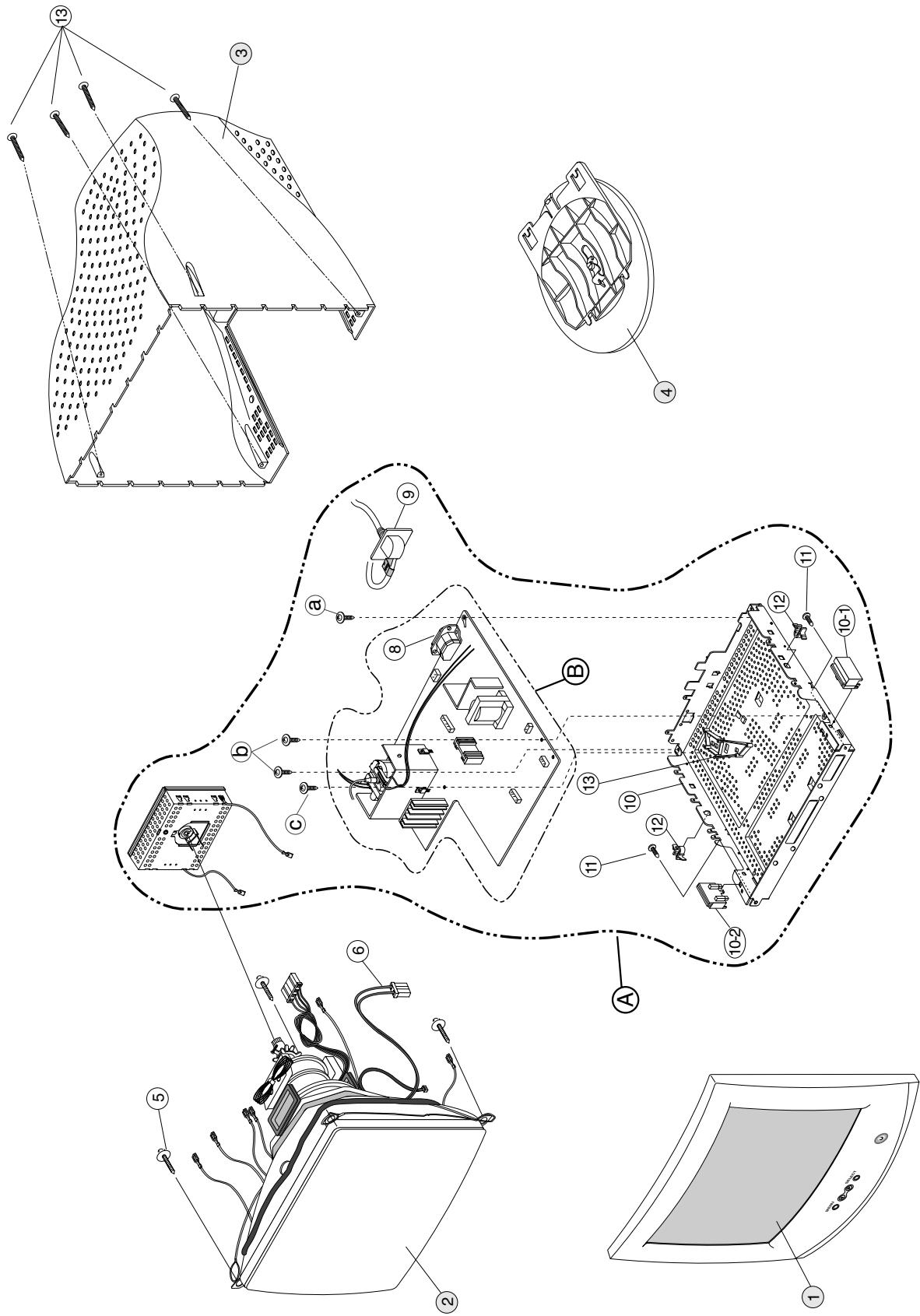
EXPLODED VIEW(710BL)



EXPLODED VIEW PARTS LIST(710BL)

Ref. No.	PART NO	DESCRIPTION
1	3091TKC099B	CABINET ASSEMBLY, 710BJ BRAND C083 S/W 700S,320T,89483,SPRING CKD,DI -For Australia(MPR2),southeast Asia(MPR2),Europe(MPR2),Indonesia(MPR2),USA/Canada(MPR2),South Africa(MPR2)
	3091TKC099C	CABINET ASSEMBLY, 710BJ BRAND C083 320T,89483,S/W710E,DI(SPRING CKD) -For southeast Asia,Europe,Israel,Asia,United Kindom,Vietnam,South Africa
	3091TKC099D	CABINET ASSEMBLY, 710BJ BRAND C083 PC+ABS,89483,S/W710B,MAADIRAN -For Europe(TCO99)
	3091TKC099E	CABINET ASSEMBLY, 710BK BRAND C083 320T,89483,S/W710E,LG RED,DI -For Chile, Panama
	3091TKC099F	CABINET ASSEMBLY, 710BK BRAND C083 S/W700E 320T 89483 LG RED -For Brazil,Panama(MX)
	3091TKC099G	710BK BRAND C083 S/W710S 320T 89483 LG RED For Brazil(MPR2),Mexico(MPR2)
	3091TKC099H	CABINET ASSEMBLY, 710BK BRAND C083 S/W710E 320T 92166BK -For Brazil(Black),Israel(Black),Asia(black(TCO)),Panama(BLACK)
	3091TKC099J	CABINET ASSEMBLY, 710BK BRAND C083 710S 320T SILVER SPRAY
	3091TKC099K	CABINET ASSEMBLY, 710B BRAND C083 BLACK(92166) MPR2 LG LOGO 1 COLOR,-For Mexico(Black)
2	3091TKC099M	CABINET ASSEMBLY, 710BK BRAND C083 BLACK(92166) MPR2 S/W710S -For Europe(Black)
	3091TKC099L	710B BRAND C083 BLACK(92166) MPR2 LG LOGO GREY -For USA/Canada
	6318L17024A	CDT(CIRC),M41LFQ803X61NDDP LG-PHILIPS DISPLAYS 70KHZ 29.1MM FST TCO PLUS
	6318L17024B	CDT(CIRC) M41LFQ803X61NDDS LG-PHILIPS DISPLAYS 70KHZ 29.1MM FST MPR PLUS
	6318L17024F	CDT(CIRC) M41LFQ503X61QDDP LG-PHILIPS DISPLAYS 70KHZ 29.1MM FST NON-MPR PLUS
	6318L17026A	CDT(CIRC) M41LFQ803X00NDDU LG-PHILIPS DISPLAYS 70KHZ 29.1MM FST TCO PLUS BARE
3	6318L17026B	CDT(CIRC) M41LFQ803X00NDDV LG-PHILIPS DISPLAYS 70KHZ 29.1MM FST MPR PLUS BARE
	6318L17026E	CDT(CIRC) M41LFQ803X00SDDV LG-PHILIPS DISPLAYS 70KHZ 29.1MM FST MPR PLUS BARE
3	3809TKC050B	BACK COVER ASSEMBLY, T710BH/PH C046 GN5008HF,8C358(EQ54) -For Europe(TCO99)
	3809TKC050C	BACK COVER ASSEMBLY, T710 C046 320T,EQ54(8C358) -For Australia(MPR2),Brazil,Brazil(MPR2),Chile,southeast Asia,southeast Asia(MPR2),Europe,Europe(MPR2),Indonesia(MPR2),Israel,Asia,Mexico(MPR2), Panama,United Kindom,USA/Canada(MPR2),Vietnam,South Africa
	3809TKC050L	BACK COVER ASSEMBLY, 710BK C046 320T 92166 BK -For Brazil(Black),Europe(Black),Indonesia(Silver),Israel(Black),Asia(black(TCO)),Mexico(Black),Panama(BLACK),USA/Canada
4	3043TKK129A	TILT SWIVEL ASSEMBLY, 710BJ T068/B060 60HR,8C358 -For Australia(MPR2),Chile,southeast Asia,Europe,Europe(TCO99,MPR2),Indonesia(MPR2),Israel,Asia,Mexico(MPR2), Panama,United Kindom,USA/Canada(MPR2),Vietnam,South Africa
	3043TKK129B	TILT SWIVEL ASSEMBLY, 710BK T068/B060 60HR,8C358 MAADIRAN CKD -For Brazil,Brazil(MPR2)
	3043TKK129C	TILT SWIVEL ASSEMBLY, 710BK T068/B060 60HR 92166 BK ,-For Europe(Black),,Indonesia(Silver),Israel(black),Asia(black(TCO))Mexico(Black),Panama(BLACK),USA/Canada
	3043TKK129D	710BL T068/B060 60HR 92166 RUBBER CKD -For Brazil(Black)
5	339-002H	SCREW ASSY, PHP+5*20(FZMY)+GW18 NEW TYPE
6	6140TC3004G	COIL,DEGAUSSING,16.0OHM 0.35MM 80T 17" L1090MM,WITH EARTH 700BJ
7	6174T11004F	FBT (FLY BACK TRANSFORMER),1063A,F700BK(71K) JUNGWOO 17"
8	6174T11006C	FBT (FLY BACK TRANSFORMER),C93 BSC25-1458 FUJIAN FURI(HITACHI) 17"/70KHZ FLAT
9	6620TKB002B	SOCKET(CIRC),POWER,SA-4S HUA JIE AC UNIVERSAL 3PIN BLACK
	6620TKB002D	SOCKET(CIRC),POWER,CDJ-3C DUOLING AC UNIVERSAL 3PIN BLACK
9	6850TA9012A	CABLE,D-SUB,UL20276-9C(5.8MM) AT 1560MM GRAY(85964) T710BJ DM
	6850TA9012C	UL20276-9C(5.8MM) AT 1500MM BLACK 9930 700BJ DM
10	4950TKS155S	METAL, SHIELD BOTTOM,CB553,0.8T,REAR HOLE DELETE -For Australia(MPR2),Chile,southeast Asia,Europe,Indonesia(MPR2,Silver),Israel,Asia, Panama,United Kindom,Vietnam,South Africa
	4950TKS212E	METAL, SHIELD BOTTOM E50 SP CKD -For Brazil,Brazil(Black,MPR2)
	4950TKS155T	METAL, SHIELD BOTTOM,1.0T/710,T710,500,505,-For Mexico(black),Mexico(MPR2),Panama(MX,BLACK),USA/Canada,USA/Canada(MPR2)
	4950TKS212D	METAL, SHIELD BOTTOM C-CKD -For Iran(S/W 710B)
11-1	4810TKK150A	BRACKET, CN771C SUPPORTER BOT.(RIGHT)
11-2	4810TKK151A	BRACKET, CN771C SUPPORTER BOT.(LEFT)
12	332-102F	SCREW, PTP+4*20BP(MSWR/FZMY)
13	4810TKK204J	700BK HOLDER FBT H-CKD -For Brazil
	4810TKK204H	BRACKET, 700BK HOLDER FBT -For Australia
14	4930TKK031C	HOLDER, PCB FIX , PC+ABS
15	4810TKK200A	BRACKET, KNOB SUPPORTER CN772G NECCI
A	3313T17358A	MAIN TOTAL ASSEMBLY,700BL BRAND CA-136
	3313T17358B	MAIN TOTAL ASSEMBLY,700BL BRAND CA-136
B	6871TMT642A	PWB(PCB) ASSEMBLY,MAIN,700BL KLRDMT BRAND CA-136 TOTAL
	6871TMT642B	PWB(PCB) ASSEMBLY,MAIN 710BL KLEUMD BRAND CA-136 TOTAL
a	332-112F	SCREW, DRAWING, D3.5 L10.0 MSWR/FZMY +SW3.5+RW3.5
b	4001TKK004E	SCREW ASSEMBLY, TAPTITE P TYPE D3.0 L10.0 MSWR/FZMY SW3+RW10
c	332-095B	SCREW, DRAWING, PZP+3*10(MSWR/FZMY)
d	332-113H	SCREW, PVP+3*16(MSWR/FZMY)
e	332-095A	SCREW, PZP+3*8 (MSWR/FZMY)

EXPLODED VIEW(773NL)



EXPLODED VIEW PARTS LIST(773NL)

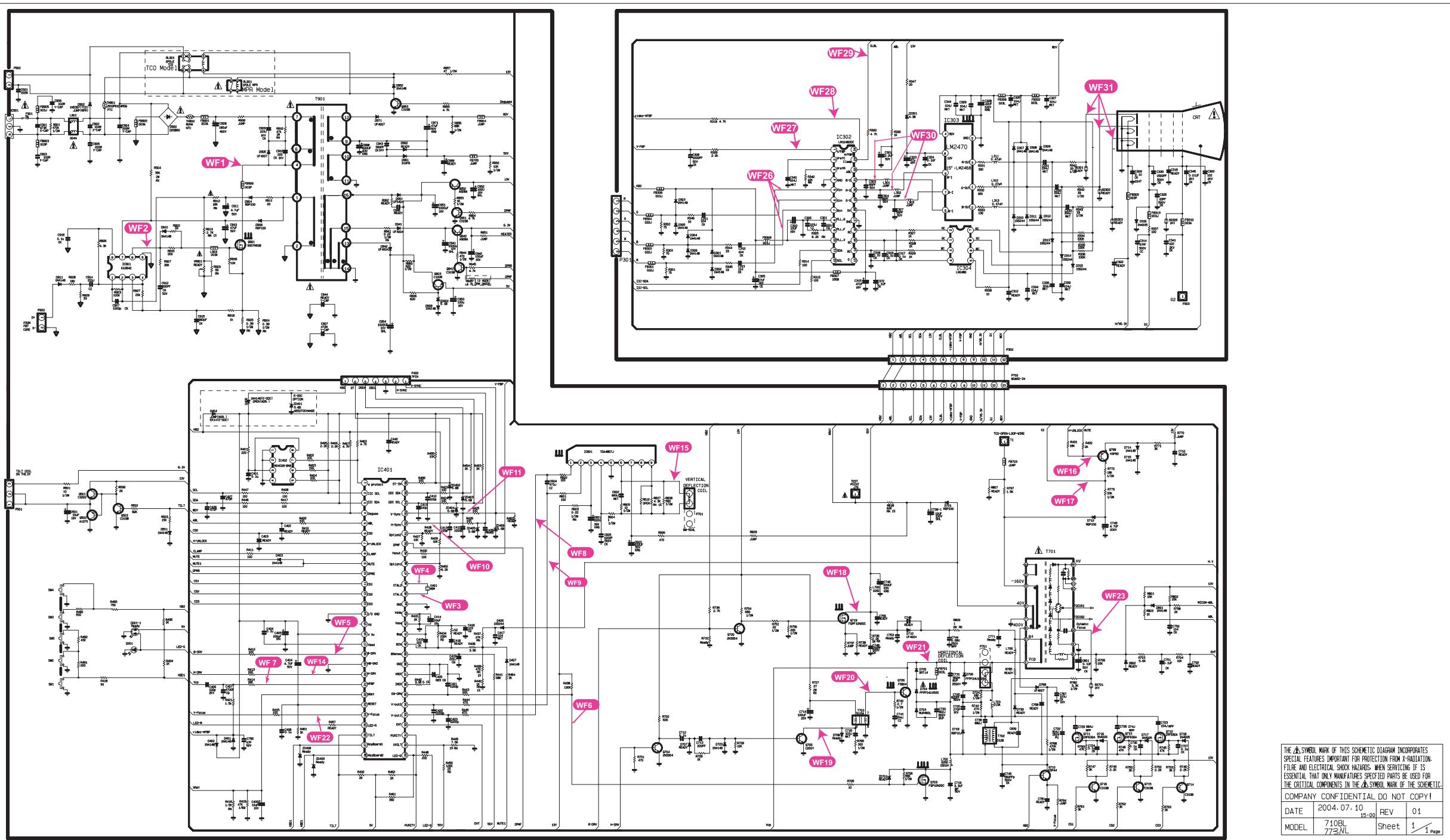
Ref. No.	PART NO	DESCRIPTION
1	3091TKC048A	CABINET ASSY,CB773D BRAND 3090TKC048A (LGENT)-For CHINA(MPR2),EUROPE(MPR2),RUSSIA(MPR2)
	3091TKC048V	CABINET ASSEMBLY,CB773H BRAND C048 PC+ABS 85964 S/W773E TCO99LABEL NT LOCAL For EUROPE(TC099),RUSSIA(TC099)
2	6318L17024A	CDT(CIRC),M41LFQ803X61NDDP LG-PHILIPS DISPLAYS 70KHZ 29.1MM FST TCO PLUS
	6318L17024B	CDT(CIRC) M41LFQ803X61NDDS LG-PHILIPS DISPLAYS 70KHZ 29.1MM FST MPR PLUS
3	3809TKC028A	BACK COVER ASSY,CB773D 3808TKC029A (LGENT) -For CHINA(MPR2),EUROPE(MPR2),RUSSIA(MPR2)
	3809TKC028B	BACK COVER ASSEMBLY,KCB773D . LUPOY,85964,NT-LOCAL -For EUROPE(TC099),RUSSIA(TC099)
4	3043TKK063B	TILT SWIVEL ASSEMBLY,KCB773D . 60HR(85964)NT LOCAL
5	339-002H	SCREW ASSY,PHP+5*20(FZMY)+GW18 NEW TYPE
6	6140TC3004G	COIL,DEGAUSSING,16.0OHM 0.35MM 80T 17" L1090MM,WITH EARTH 700BJ
7	6174T11004F	FBT (FLY BACK TRANSFORMER),1063A,F700BK(71K) JUNGWOO 17"
	6174T11006C	FBT (FLY BACK TRANSFORMER),C93 BSC25-1458 FUJIAN FURI(HITACHI) 17"/70KHZ FLAT
8	6620TKB002B	SOCKET(CIRC),POWER,SA-4S HUA JIE AC UNIVERSAL 3PIN BLACK
	6620TKB002D	SOCKET(CIRC),POWER,CDJ-3C DUOLING AC UNIVERSAL 3PIN BLACK
9	6850TA9012A	CABLE,D-SUB,UL20276-9C(5.8MM) AT 1560MM GRAY(85964) T710BJ DM
10	4950TKS155A	METAL,SHIELD BOTTOM, CB776
10-1	4810TKK153A	BRACKET,CB773D SUPPORTER CDT
10-2	4810TKK154A	BRACKET,CB773D SUPPORTER CDT(L)
11	332-102F	SCREW,PTP+4*20BP(MSWR/FZMY)
12	4930TKK017A	HOLDER,D-COIL DONG-A(DAC-20)
13	332-122B	SCREW,DRAWING,D4.0 L16.0 FZMY1
A	3313T17358E	MAIN TOTAL ASSEMBLY,773NL BRAND CA-136
	3313T17358H	MAIN TOTAL ASSEMBLY,773NL BRAND CA-136
	3313T17358J	MAIN TOTAL ASSEMBLY,773NL BRAND CA-136
B	6871TMT642E	PWB(PCB) ASSEMBLY,MAIN,773NL KLRUET BRAND CA-136 TOTAL
	6871TMT642H	PWB(PCB) ASSEMBLY,MAIN 773NL KLCNMT BRAND CA-136 TOTAL
	6871TMT642J	PWB(PCB) ASSEMBLY,MAIN 773NL KLRUET BRAND CA-136 TOTAL
a	332-112F	SCREW,DRAWING,D3.5 L10.0 MSWR/FZMY +SW3.5+RW3.5
b	4001TKK004E	SCREW ASSEMBLY,TAPTITE P TYPE D3.0 L10.0 MSWR/FZMY SW3+RW10
c	332-095B	SCREW,DRAWING,PZP+3*10(MSWR/FZMY)

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*S	*AL	LOC NO.	PART NO.	DESCRIPTION/SPECIFICATON
△	C914	0CZZTFT001P	ECQB1H153JM3 153J 50V TP5.0	
	C915	0CK6810K515	MATSUSHITA 680P 50V K B TS	
	C917	0CK1020K515	1000PF 50V K B TR	
	C918	0CK1040K945	0.1UF 50V Z F TR	
	C921	0CZZTCB003A	BULK 7.5 CS E 222M 10.5 250V TDK	
	C941	0CE108CD618	1000UF SHL 10V M FL TP5	
	C942	0CE107CF638	1000UF SHL,SD 16V M FM5 TP 50	
	C943	0CK56101515	560P 1KV K B TS	
	C951	0CE108CF630	1000UF SHL 16V M FM5 BULK	
	C952	0CE107CF638	1000UF SHL,SD 16V M FM5 TP 50	
DIODE	C953	0CE107CF638	1000UF SHL,SD 16V M FM5 TP 50	
	C954	0CE108CD618	1000UF SHL 10V M FL TP5	
	C971	0CE476EK638	47UF KMG 50V M FM5 TP 5	
	C998	0CE227EL630	220UF KMG 63V M FM5 BULK	
	ZD301	0DZPT43009A	UZ-4.3BSB PCTRONIX TP DO34 500MW 4.3BV 5MA (52MMTP)PF	
	ZD402	0DZPT56009A	UZ-5.6BSB PCTRONIX TP52 DO34 500MW 5.6BV 5MA PF	
	ZD403	0DZPT56009A	UZ-5.6BSB PCTRONIX TP52 DO34 500MW 5.6BV 5MA PF	
	ZD404	0DZPT56009A	UZ-5.6BSB PCTRONIX TP52 DO34 500MW 5.6BV 5MA PF	
	ZD405	0DZPT56009A	UZ-5.6BSB PCTRONIX TP52 DO34 500MW 5.6BV 5MA PF	
	ZD406	0DZPT56009A	UZ-5.6BSB PCTRONIX TP52 DO34 500MW 5.6BV 5MA PF	
△	ZD902	0DZPT51009A	UZ-5.1BSB PCTRONIX TP DO34 500MW 5.1BV 5MA PF	
	D306	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D307	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D308	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D309	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D310	0DSPT00019A	PSS244 PCTRONIX TP DO34 280V 625MA 1000MA 50NSSEC 10UA	
	D311	0DSPT00019A	PSS244 PCTRONIX TP DO34 280V 625MA 1000MA 50NSSEC 10UA	
	D312	0DSPT00019A	PSS244 PCTRONIX TP DO34 280V 625MA 1000MA 50NSSEC 10UA	
	D313	0DSPT00019A	PSS244 PCTRONIX TP DO34 280V 625MA 1000MA 50NSSEC 10UA	
	D314	0DSPT00019A	PSS244 PCTRONIX TP DO34 280V 625MA 1000MA 50NSSEC 10UA	
△	D315	0DSPT00019A	PSS244 PCTRONIX TP DO34 280V 625MA 1000MA 50NSSEC 10UA	
	D316	0DRTW00119A	1N4005-1021 TIWAN SEMI TP DO41 600V 1A 30A 2USSEC 5.0UA	
	D401	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D402	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D403	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D406	0DSPT00019A	PSS244 PCTRONIX TP DO34 280V 625MA 1000MA 50NSSEC 10UA	
	D407	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D501	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D703	0DRGF00120A	MUR460(15MM) GULF BK DO201AD 600V	
	D704	0DRFC00300A	4A 150A 45NSSEC 10UA FFPF04U150S FAIR CHILD BK TO220F	
△	D705	0DRTW00089A	1500V 4A 40A 150NSSEC 7UA SRT14(1021) TIWAN SEMI TP NON 40V 1A 25A SEC 0.5MA	
	D706	0DRFC00300A	FFPF04U150S FAIR CHILD BK TO220F	
	D710	0DR400409AC	1500V 4A 40A 150NSSEC 7UA UF4004 GULF TP DO41 400V 1A 30A 50NSEC 10UA	
	D712	0DR100009CD	RGP10G-1021 TIWAN SEMI TP DO41 400V 1A 30A 150NSEC 5UA	
	D714	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D715	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D716	0DRTW00119A	1N4005-1021 TIWAN SEMI TP DO41 600V 1A 30A 2USSEC 5.0UA	
	D717	0DRTW00119A	1N4005-1021 TIWAN SEMI TP DO41 600V 1A 30A 2USSEC 5.0UA	
	D718	0DRTW00119A	1N4005-1021 TIWAN SEMI TP DO41 600V 1A 30A 2USSEC 5.0UA	
	D719	0DR100009DC	RGP10J-1021 TIWAN SEMI TP DO41 600V 1A 30A 250NSEC 5UA	
△	D721	0DR100009CD	RGP10G-1021 TIWAN SEMI TP DO41 400V 1A 30A 150NSEC 5UA	
	D723	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D724	0RD1800A609	180 OHM 1/2 W (7.0) 5% TA52	
	D768	0DD400709CC	UF4007-1021 TIWAN SEMI TP DO204AL 1000V 1A 30A 75NSSEC 10UA	
	D801	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D900	0DRTW00121A	D2S860-1121 TIWAN SEMI ST GBL 600V 2A 80A SEC 10UA	
	D902	0DRGF00139A	GPP20J GULF TP DO15 600V 2.0A 70A 2.0USSEC 5.0UA	
	D904	0DR100009CD	RGP10G-1021 TIWAN SEMI TP DO41 400V 1A 30A 150NSEC 5UA	
	D905	0DD400709CC	UF4007-1021 TIWAN SEMI TP DO204AL 1000V 1A 30A 75NSSEC 10UA	
	D906	0DR100009CD	RGP10G-1021 TIWAN SEMI TP DO41 400V 1A 30A 150NSEC 5UA	
△	D908	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D910	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D911	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D941	0DR400409AC	UF4004 GULF TP DO41 400V 1A 30A 50NSEC 10UA	
	D942	0DR400409AC	UF4004 GULF TP DO41 400V 1A 30A 50NSEC 10UA	
	D951	0DRGF00150A	UF5404 GULF BK DO201AD 400V 3.0A 150A 50NSSEC 10.0UA	
	D952	0DSPT00029A	1N4148M PCTRONIX TP DO34 100V 75VA 2000MA 4NSEC 0.025UA	
	D961	0DRGS00090A	31GF6L-5701 GENERAL SEMICONDUCTOR BK NON 600V 3A 60A 30NSEC 20UA	
	D971	0DD400709CC	UF4007-1021 TIWAN SEMI TP DO204AL 1 000V 1A 30A 75NSSEC 10UA	
	Coil			
		L311	OLA0470K119	0.47UH K 2.3*3.4 TP
		L312	OLA0470K119	0.47UH K 2.3*3.4 TP
		L313	OLA0470K119	0.47UH K 2.3*3.4 TP
		L702	6140TBZ025D	Ø - H-SIZE, DR 12*20-C6.0, 150UH 700BJØ

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*S	*AL	LOC NO.	PART NO.	DESCRIPTION/SPECIFICATON
⚠	L703	6140TYZ013A	QX31 SAMHWA DR14*15-C5.2,17.5T,5.6UHTÓ	
	L705	6140TBZ026C	DR15*18-C9.8 100UH 0.1*30MM 40.5T D/D CHOKE	
	L901	6200TZ004A	QE2626 NAMYANG BK L/FILTER	
		15MH,EB770HÓ		
	L903	6210TCE003K	BAS3550T BO SUNG 3550MM AXIAL52MM	
	FB305	6210TCE003P	BRS2550B BO SUNG 2550MM RADIAL	
	FB306	6210TCE003L	BAS3580T BO SUNG 3580MM AXIAL52MM	
	FB307	6210TCE003B	BRS3580B BO SUNG 3580MM RADIAL	
	FB308	6210TCE003J	BAS2550T BO SUNG 2550MM AXIAL52MM	
	FB309	6210TCE003J	BAS2550T BO SUNG 2550MM AXIAL52MM	
	FB310	6210TCE003A	BRD3510B BO SUNG 3510MM RADIAL	
	FB313	6210TCE003J	BAS2550T BO SUNG 2550MM AXIAL52MM	
	FB701	6210TCE003L	BAS3580T BO SUNG 3580MM AXIAL52MM	
	FB903	6210TCE003P	BRS2550B BO SUNG 2550MM RADIAL	
	FB905	6210TCE003J	BAS2550T BO SUNG 2550MM AXIAL52MM	
	FB906	6210TCE003P	BRS2550B BO SUNG 2550MM RADIAL	
	FB921	6210TCE003A	BRD3510B BO SUNG 3510MM RADIAL	
	FB922	6210TCE003A	BRD3510B BO SUNG 3510MM RADIAL	
IC				
	IC302	OIPRPNS025C	QM1246DDC/NA NATIONAL SEMICONDUCTOR 24,DIP ST ONE CHIP (VIDEO+OSD)Ó	
	IC303	OIPRPNS050A	LM2470TA NATIONAL SEMICONDUCTOR 9PIN TA09A ST MONOLITHIC TRIPLE 7.0NS CRT DRIVER	
	IC304	OIPRPNS005A	QM2480NA NATIONAL SEMICONDUCTOR 8P,DIP ST 80V TRIPLE BIAS CLAMPÓ	
	IC401	OIMCRPH033A	SAA4849(OTP) PHILIPS 56PIN SDIP - DEFLECTION AND MICOM	
	IC402	OIMMRSG044A	M24C08-WBN6 STM 8PIN PDIP ST SERIAL IIC EEPROM	
	IC601	OIPRPPH018A	QDA4867J PHILIPS 9PIN,ST DIP VERTICAL OUTPUT ICÓ	
	IC901	OIS5384200A	KA3842B (PWM)	
TRANSISTOR				
⚠	Q501	OTR320209AA	KTC3202-Y(KTC1959) TP KEC TO92 NPN	
	Q502	OTR127009AA	KTA1270-Y(KTA562TM) TP KEC TO92 PNP	
	Q503	OTR319809AA	KTC3198-Y(KTC1815) TP KEC TO92 NPN	
	Q703	OTFFC10012A	FQPF10N20C FAIRCHILD ST TO220F 200V 9.5A	
	Q704	OTR390409CA	FAIRCHILD 2N3904(TA) TP TO-92 60V 0.2A	
	Q705	OTR200009AB	KTC200-Y TP KEC TO92 NPN	
	Q706	OTRFC10008A	FJAF5804(TU) FAIRCHILD ST TO3PF 1500V 12A	
	Q710	OTRKE90020A	MPSA44 KEC TP TO92 500V 300MA	
	Q711	OTF630001BB	SGS-T(STM) IRF630MFP ST TO220F 200V 5A	
	Q712	OTF630001BB	SGS-T(STM) IRF630MFP ST TO220F 200V 5A	
	Q713	OTF630001BB	SGS-T(STM) IRF630MFP ST TO220F 200V 5A	
	Q714	OTR319809AA	KTC3198-Y(KTC1815) TP KEC TO92 NPN	
	Q715	OTR319809AA	KTC3198-Y(KTC1815) TP KEC TO92 NPN	
	Q716	OTR319809AA	KTC3198-Y(KTC1815) TP KEC TO92 NPN	
	Q719	OTFFC10012A	FQPF10N20C FAIRCHILD ST TO220F 200V 9.5A	
	Q720	OTR390409CA	FAIRCHILD 2N3904(TA) TP TO-92 60V 0.2A	
	Q799	OTRKE90019A	MPSA92 KEC TP TO92 -300V -500MA	
	Q901	OTF760000AD	SS57N60B FAIRCHILD ST TO220F 650V 7A	
	Q903	OTR100809AA	KSC1008C-Y TP SAMSUNG TO92 NPN	
	Q941	OTR319809AA	KTC3198-Y(KTC1815) TP KEC TO92 NPN	
	Q942	OTR127309AA	KTA1273-Y(KTA966A) TP KEC TO92 PNP	
	Q951	OTR319809AA	KTC3198-Y(KTC1815) TP KEC TO92 NPN	

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*S	*AL	LOC NO.	PART NO.	DESCRIPTION/SPECIFICATON
		R929	ORD0332Q609	33 1/4W(3.5% TA52
		R941	ORN0220H609	0.22 1/2W 5% TA52
		R944	ORD4700A609	470 OHM 1/2 W (7.0) 5% TA52
		R945	ORD4701Q609	4.70K 1/4W(3.5% TA52
		R952	ORD1202A609	12K OHM 1/2 W(7.0) 5.00% TA52
		R953	ORD1001A609	1K OHM 1/2 W (7.0) 5% TA52
		R954	ORD4701Q609	4.70K 1/4W(3.5% TA52
		R955	ORD4701Q609	4.70K 1/4W(3.5% TA52
		R956	ORD6802A609	68K OHM 1/2 W (7.0) 5% TA52
		R957	ORD0472A609	47 OHM 1/2 W (7.0) 5% TA52
		R960	ORD6200A609	620 OHM 1/2 W(7.0) 5.00% TA52
Other				
△		RL901	6920TBB007A	JZC-42012-2HS HONGMEI 250VAC 5A 12V 2A NO VENTING
		SC301	6620TBD003A	PCS701E PARK ELEC. 10PIN 14/360 STRAIGHT
		SC901	6620TKB002B	SA-4S HUA JIE AC UNIVERSAL 3PIN BLACK
		SG305	6918TRT005A	GS-102-A0,1KV SMART RADIAL TAPINGÓ
		SG701	6918TRT005A	GS-102-A0,1KV SMART RADIAL TAPINGÓ
		SW201	6600R00001A	OTP1280F6 JEIL 12V DC 1MA VERTICAL,7MMÓ
		SW202	6600R00001A	OTP1280F6 JEIL 12V DC 1MA VERTICAL,7MMÓ
		SW203	6600R00001A	OTP1280F6 JEIL 12V DC 1MA VERTICAL,7MMÓ
		SW204	6600R00001A	OTP1280F6 JEIL 12V DC 1MA VERTICAL,7MMÓ
		SW205	6600R00001A	OTP1280F6 JEIL 12V DC 1MA VERTICAL,7MMÓ
△		SW206	6600R00001A	OTP1280F6 JEIL 12V DC 1MA VERTICAL,7MMÓ
		SW207	6600R00001A	OTP1280F6 JEIL 12V DC 1MA VERTICAL,7MMÓ
		T1	6631T11005D	1 W-T 480MM UL 1015 AWG 22 CB775C
		T701	6174T11004F	Q063A,F700BK(71K) JUNGWOO 1700
		T702	6170TCZ012B	QE1916 1.6MH FOCUS TRANS,700BJÓ
		T703	6170TCZ015A	QI-19 4.45MH H-DRIVE,700BJÓ
		T901	6170TMZ153A	EER3435 300UH V-16PIN T710BL
		TH901	SI/SC/NY/JS /TC	71-85KHZ
		TH902	6322B00002D	MZ72-4.5RN290V GAOLI 4.5OHM +30% - 20% 2PIN BOX
		X401	6322A00003C	8 D2 10 SEMITEC 80HM 15% D(11.5)
			6212AA2003E	HC-49U SOUTH STAR 48MHZ +/- 20 PPM 22PF BULK

SCHEMATIC DIAGRAM



THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION, FIRE AND ELECTRICAL SHOCK HAZARDS. WHEN SERVICING IT IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC. COMPANY CONFIDENTIAL DO NOT COPY!
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